

16-bit Proprietary Microcontroller

CMOS

F²MC-16LX MB90945 Series

MB90F946A/947A/F947A/F949A/V390HB

■ DESCRIPTION

The MB90945 series with one FULL-CAN interface and FLASH ROM is especially designed for automotive HVAC applications. Its main feature is the on board CAN Interface, which conform to V2.0 Part A and Part B, while supporting a very flexible message buffer scheme and so offering more functions than a normal FULL-CAN approach. With the new 0.35 μm CMOS technology, Fujitsu Microelectronics now offers on-chip FLASH-ROM program memory up to 384 K bytes. An internal voltage booster removes the necessity for a second programming voltage.

An on board voltage regulator provides 3 V to the internal MCU core. This creates a major advantage in terms of EMI and power consumption.

The internal PLL clock frequency multiplier provides an internal 42 ns instruction cycle time from an external 4 MHz clock.

The unit features a 4-channel Output Compare Unit and a 6-channel Input Capture Unit with two separate 16-bit free-run timers. Up to 3 UARTs, one Serial I/O and one I²C constitute additional functionality for communication purposes.

Note: F²MC is the abbreviation of FUJITSU Flexible Microcontroller.

For the information for microcontroller supports, see the following web site.

<http://edevic.fujitsu.com/micom/en-support/>

■ FEATURES

- 16-bit core CPU; 4 MHz external clock (24 MHz internal, 42 ns instr. cycle time)
- New 0.35 μ m CMOS Process Technology
- Internal voltage regulator supports 3 V MCU core, offering low EMI and low power consumption figures
- One FULL-CAN interface; conforming to Version 2.0 Part A and Part B, flexible message buffering (mailbox and FIFO buffering can be mixed)
- Powerful interrupt functions (8 progr. priority levels; 8 external interrupts)
- EI²OS - Automatic transfer function independent of CPU; 16 channels of intelligent I/O Services
- 18-bit Time-base counter
- Watchdog Timer
- 1 full duplex UART; support 10.4 KBAud (USA standard)
- up to 2 full duplex UARTs (LIN/SCI/SPI)
- 1 Serial I/O (SPI)
- 1 I²C interface
- A/D Converter : 15 channels analog inputs (Resolution 10-bit or 8-bit)
- 16-bit reload timer $\times$ 1channel
- ICU (Input capture) 16-bit $\times$ 6 channels
- OCU (Output compare) 16-bit $\times$ 4 channels
- 16-bit free-run timer $\times$ 2 channels (FRT0 : ICU 0/1, OCU 0/1/2/3, FRT1 : ICU 2/3/4/5)
- 8/16-bit Programmable Pulse Generator 6 channels $\times$ 8/16-bit
- Optimized instruction set for controller applications (bit, byte, word and long-word data types; 23 different addressing modes; barrel shift; variety of pointers)
- 4-byte instruction execution queue
- signed multiply (16-bit $\times$ 16-bit) and divide (32-bit/16-bit) instructions available
- Program Patch Function (3 address match registers)
- Fast Interrupt processing
- Low Power Consumption mode
 - Sleep mode
 - Timebase timer mode
 - Stop mode
 - CPU intermittent mode
- Automotive input levels
- Package : 100-pin plastic QFP

MB90945 Series

■ PRODUCT LINEUP

Part Number Parameter	MB90947A	MB90F946A	MB90F947A, MB90F949A	MB90V390HB
CPU	F ² MC-16LX CPU			
System clock	On-chip PLL clock multiplier (×1, ×2, ×3, ×4, ×6, 1/2 when PLL stops) Minimum instruction execution time : 42 ns (4 MHz oscillation clock, PLL clock multiplied by 6)			
ROM	ROM memory 128 Kbytes	Boot-block Flash memory 384 Kbytes	Boot-block Flash memory 256 Kbytes: MB90F949A 128 Kbytes: MB90F947A	External
RAM	6 Kbytes	16 Kbytes	12 Kbytes: MB90F949A 6 Kbytes: MB90F947A	30 Kbytes
Emulator-specific power supply ¹	—			Yes
Technology	0.35 μm CMOS with on-chip voltage regulator for internal power supply	0.35 μm CMOS with on-chip voltage regulator for internal power supply + Flash memory with on-chip charge pump for programming voltage		0.35 μm CMOS with on-chip voltage regulator for internal power supply
Operating voltage range	3.5 V to 5.5 V : other than conditions listed below 4.0 V to 5.5 V : when writing to Flash 4.5 V to 5.5 V : if A/D Converter is used			5 V ± 10%
Temperature range	−40 °C to +105 °C			—
Package	QFP-100P			PGA-299C
UART	1 channel			2 channels
	Full duplex double buffer Supports asynchronous/synchronous (with start/stop bit) transfer Baud rate : 4808/9615/10417/19230/38460/62500/500000 bps (asynchronous) 500 K/1 M/2 Mbps (synchronous) at System clock = 20 MHz			
UART (LIN/SCI/SPI)	1 channel	2 channels	1 channel	2 channels
Serial I/O	1 channel Transfer can be started from MSB or LSB Supports internal clock synchronized transfer and external clock synchronized transfer Supports positive-edge and negative-edge clock synchronization Baud rate : 31.25 K/62.5 K/125 K/500 K/1 Mbps at System clock = 20 MHz			
I ² C (400 Kbps)	1 channel			

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MB90945 Series

Part Number Parameter	MB90947A	MB90F946A	MB90F947A, MB90F949A	MB90V390HB
A/D Converter (15 input channels)	10-bit or 8-bit resolution Conversion time : Min 4.9 μs includes sample time (per one channel, only at certain machine clock frequencies)			
16-bit Reload Timer	1 channel			2 channels
	Operation clock frequency : fsys/2 ¹ , fsys/2 ³ , fsys/2 ⁵ (fsys = System clock frequency) Supports External Event Count function			
16-bit Free-Run Timer (2 channels)	Signals an interrupt when overflowing Supports Timer Clear when a match with Output Compare (ch0) Operation clock freq. : fsys, fsys/2 ¹ , fsys/2 ² , fsys/2 ³ , fsys/2 ⁴ , fsys/2 ⁵ , fsys/2 ⁶ , fsys/2 ⁷ (fsys = System clock freq.) 16-bit Free-Run Timer 0 (clock input FRCK0) corresponds to ICU 0/1, OCU 0/1/2/3 16-bit Free-Run Timer 1 (clock input FRCK1) corresponds to ICU 2/3/4/5			
16-bit Input Capture (6 channels)	Rising edge, falling edge or rising & falling edge sensitive Six 16-bit Capture registers Signals an interrupt upon external event			
	—			ICU 3/5 inputs are shared with OCU 6/7 outputs
16-bit Output Compare	4 channels			8 channels
	Signals an interrupt when a match with 16-bit Free-Run Timer Eight 16-bit compare registers. A pair of compare registers can be used to generate an output signal.			
	—			ICU 3/5 inputs are shared with OCU 6/7 outputs
8/16-bit Programmable Pulse Generator (6 channels)	Supports 8-bit and 16-bit operation modes Twelve 8-bit reload counters Twelve 8-bit reload registers for L pulse width Twelve 8-bit reload registers for H pulse width A pair of 8-bit reload counters can be configured as one 16-bit reload counter or as 8-bit prescaler plus 8-bit reload counter Operation clock freq. : fsys, fsys/2 ¹ , fsys/2 ² , fsys/2 ³ , fsys/2 ⁴ or 102.4 μs (fosc = 5 MHz) (fsys = System clock frequency, fosc = Oscillation clock frequency)			
CAN Interface	1 channel			5 channels
	Conforms to CAN Specification Version 2.0 Part A and B Automatic re-transmission in case of error Automatic transmission responding to Remote Frame Prioritized 16 message buffers for data and ID's Supports multiple messages Flexible configuration of acceptance filtering : Full-bit compare/Full-bit mask/Two partial bit masks Supports up to 1 Mbps			

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MB90945 Series

Part Number Parameter	MB90947A	MB90F946A	MB90F947A, MB90F949A	MB90V390HB
External Interrupt (8 channels)	Can be programmed edge sensitive or level sensitive			
Stepping motor controller	—			2 channels
Watch Timer	—			1 channel
Sound generator	—			1 channel
Machine clock out-put	—			2 channels (non-inverted and inverted)
Program patch function	3 address match registers			5 address match registers
I/O Ports	Virtually all external pins can be used as general purpose I/O All push-pull outputs Bit-wise programmable as input/output or peripheral signal			
	Automotive input level (P21/RX1, P42/SDA, P43/SCL have CMOS Schmitt input level)			Port-wise program-mable as Automotive (default) or CMOS Schmitt input level
I/O Ports with 4 mA CMOS output	All ports except P42, P43			All ports except P80, P81, PA0 to PA7, P42, P43
I/O Ports with 3 mA CMOS output	P42, P43			P42, P43
I/O Ports with 30 mA CMOS output with slewrate control	—			P80, P81, PA0 to PA7
Clock Modulator	Phase modulation mode	Phase modulation mode		Frequency and phase modulation mode
	Reduces EMI by modulating the PLL clock			
Start-up time at power-on reset	3 × 2 ¹⁶ oscillation cycles (49.152 ms at 4 MHz oscillation) + oscillation time of oscillator*2			2 ¹⁸ oscillation cycles (65.536 ms at 4 MHz oscillation) + oscillation time of oscillator*2

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MB90945 Series

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Part Number Parameter	MB90947A	MB90F946A	MB90F947A, MB90F949A	MB90V390HB
Flash Memory	—	Supports automatic programming, Embedded Algorithm Write/Erase/Erase-Suspend/Resume commands A flag indicating completion of the algorithm Number of erase cycles : 10,000 times Data retention time : 20 years* ³ Hard-wired reset vector available in order to point to a fixed boot sector in Flash Memory (address FFA000 _H , mode data 00 _H) Boot block configuration Erase can be performed on each block Block protection with external programming voltage Write and erase at $F_{max} = 20$ MHz		—

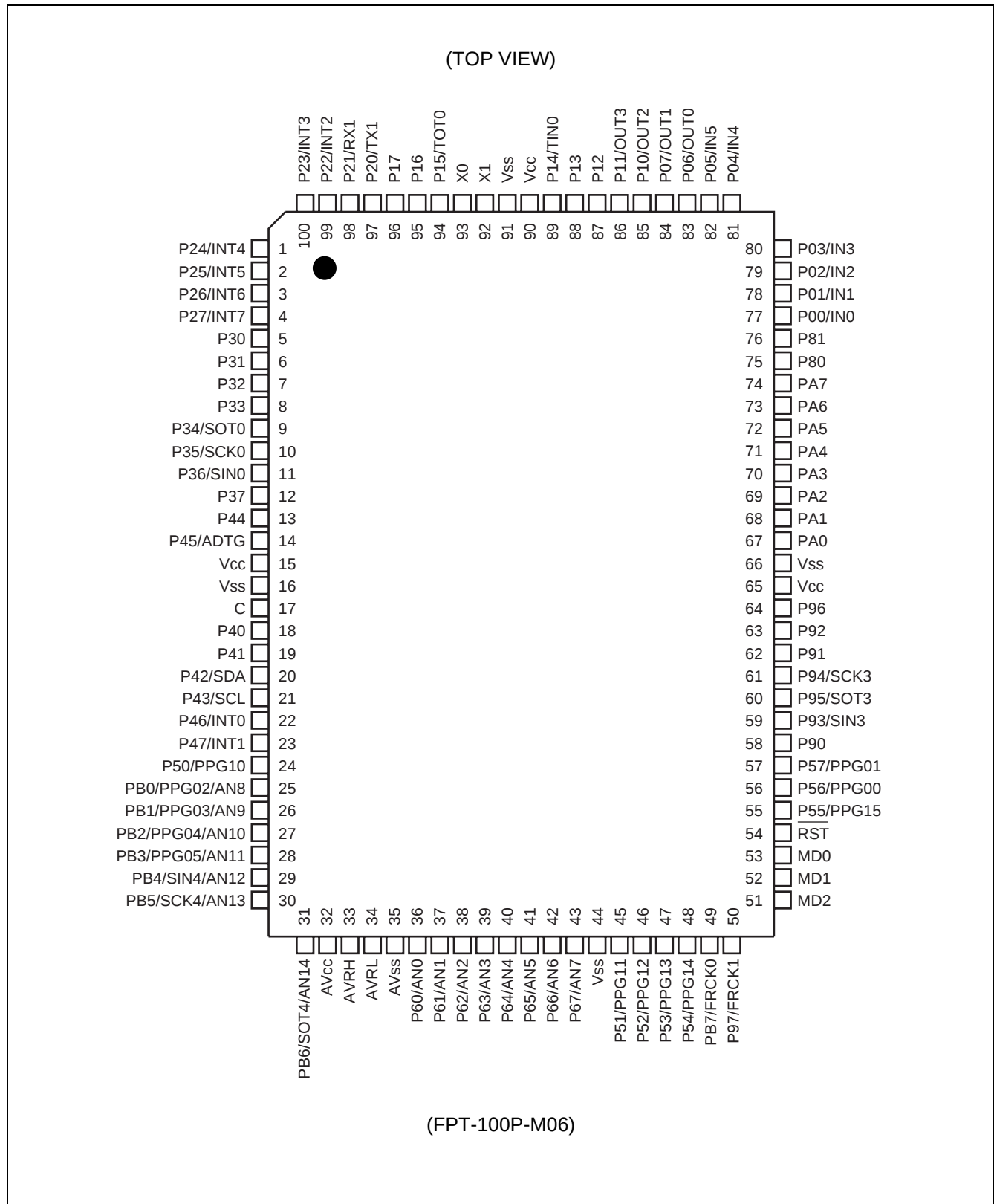
*1 : It is setting of Jumper switch SI when Emulation Pod (MB2147) is used.
Please refer to the Emulator hardware manual about details.

*2 : Oscillation time of the oscillator is the time that the amplitude reaches 90%.

*3 : Data is based on reliability tests during process qualification (the value for $T_A = +85$ °C is calculated via the Arrhenius formula from data of accelerated measurements at elevated temperature) .

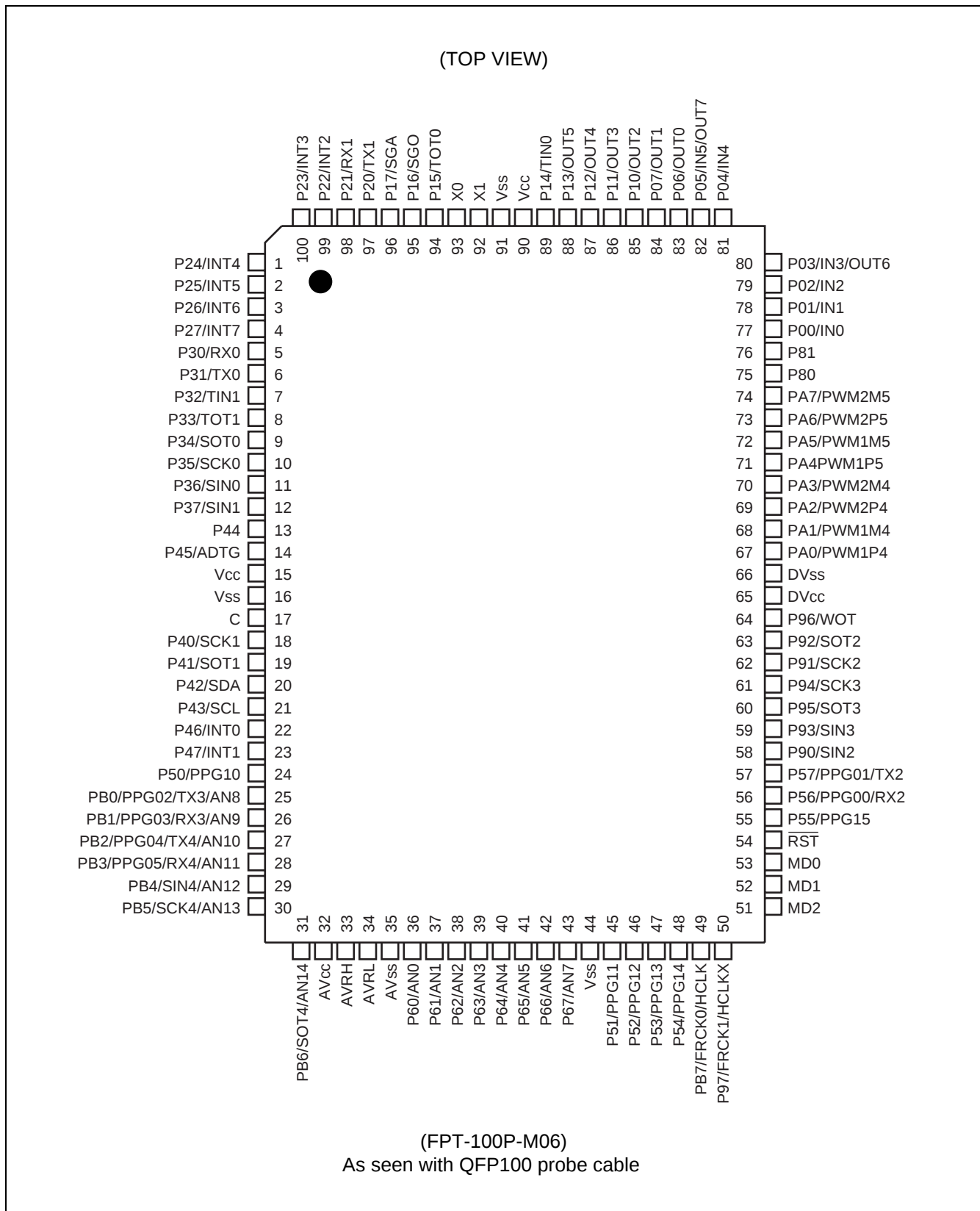
PIN ASSIGNMENTS

- MB90947A/F946A/F947A/F949A



MB90945 Series

- MB90V390HB



■ PIN DESCRIPTION

Pin no.	Pin name	Circuit type	Function
92	X1	A	Pin for oscillation
93	X0		Pin for oscillation
54	$\overline{\text{RST}}$	B	Reset input
77 to 82	P00 to P05	D	General purpose I/O
	IN0 to IN5		Inputs for the Input Captures 0-5
83 to 86	P06, P07, P10, P11	D	General purpose I/O
	OUT0 to OUT3		Outputs for the Output Compares
87, 88	P12, P13	D	General purpose I/O
89	P14	D	General purpose I/O
	TIN0		TIN0 input for the 16-bit Reload Timer 0
94	P15	D	General purpose I/O
	TOT0		TOT0 output for the 16-bit Reload Timer 0
95, 96	P16, P17	D	General purpose I/O
97	P20	D	General purpose I/O
	TX1		TX output for CAN Interface 1
98	P21	F	General purpose I/O
	RX1		RX input for CAN Interface 1
99, 100, 1 to 4	P22 to P27	D	General purpose I/O
	INT2 to INT7		External interrupt inputs for INT2 to INT7
5 to 8	P30 to P33	D	General purpose I/O
9	P34	D	General purpose I/O
	SOT0		SOT output for UART0
10	P35	D	General purpose I/O
	SCK0		SCK input/output for UART0
11	P36	D	General purpose I/O
	SIN0		SIN input for UART0
12	P37	D	General purpose I/O
13	P44	D	General purpose I/O
14	P45	D	General purpose I/O
	ADTG		External trigger input of the A/D Converter
18, 19	P40, P41	D	General purpose I/O
20	P42	F	General purpose I/O
	SDA		Serial data for I ² C interface

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Pin no.	Pin name	Circuit type	Function
21	P43	F	General purpose I/O
	SCL		Serial clock for I ² C interface
22, 23	P46, P47	D	General purpose I/O
	INT0, INT1		External interrupt inputs for INT0, INT1
24	P50	D	General purpose I/O
	PPG10		Output for the PPG1
25 to 28	PB0 to PB3	E	General purpose I/O
	PPG02 to PPG05		Outputs for the PPG4, 6, 8, A
	AN8 to AN11		Inputs for the A/D Converter
29	PB4	E	General purpose I/O
	SIN4		SIN input for Serial I/O
	AN12		Input for the A/D Converter
30	PB5	E	General purpose I/O
	SCK4		SCK input/output for Serial I/O
	AN13		Input for the A/D Converter
31	PB6	E	General purpose I/O
	SOT4		SOT output for Serial I/O
	AN14		Input for the A/D Converter
36 to 43	P60 to P67	E	General purpose I/O
	AN0 to AN7		Inputs for the A/D Converter
45 to 48	P51 to P54	D	General purpose I/O
	PPG11 to PPG14		Outputs for the PPG3, 5, 7, 9
49	PB7	D	General purpose I/O
	FRCK0		FRCK0 input for the 16-bit free-run Timer 0
50	P97	D	General purpose I/O
	FRCK1		FRCK1 input for the 16-bit free-run Timer 1
55	P55	D	General purpose I/O
	PPG15		Outputs for the PPGB
56, 57	P56, P57	D	General purpose I/O
	PPG00, PPG01		Outputs for the PPG0, PPG2
58	P90	D	General purpose I/O
	SIN2		SIN input for UART 2 (LIN/SCI/SPI) (only MB90V390HB and MB90F946A)
59	P93	D	General purpose I/O
	SIN3		SIN input for UART3 (LIN/SCI/SPI)

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Pin no.	Pin name	Circuit type	Function
60	P95	D	General purpose I/O
	SOT3		SOT output for UART3 (LIN/SCI/SPI)
61	P94	D	General purpose I/O
	SCK3		SCK input/output for UART3 (LIN/SCI/SPI)
62	P91	D	General purpose I/O
	SCK2		SCK input/output for UART 2 (LIN/SCI/SPI) (only MB90V390HB and MB90F946A)
63	P92	D	General purpose I/O
	SOT2		SOT output for UART 2 (LIN/SCI/SPI) (only MB90V390HB and MB90F946A)
64	P96	D	General purpose I/O
67 to 74	PA0 to PA7	H	General purpose I/O. For the EVA device, these pins are high current outputs.
75, 76	P80, P81	H	General purpose I/O. For the EVA device, these pins are high current outputs.
32	AV _{cc}	—	Dedicated power supply pin (5 V) for the A/D converter
33	AVRH	—	Dedicated pos. reference voltage pin for the A/D converter
34	AVRL	—	Dedicated neg. reference voltage pin for the A/D converter
35	AV _{ss}	—	Dedicated power supply pin (0 V) for the A/D converter
52, 53	MD1, MD0	C	These are input pins used to designate the operating mode. They should be connected directly to V _{CC} or V _{SS} .
51	MD2	G	This is an input pin used to designate the operating mode. It should be connected directly to V _{CC} or V _{SS} .
15, 65, 90	V _{CC}	—	These are power supply (5 V) input pins. For the EVA device, pin 65 is the DV _{CC} supply pin for the high current outputs.
16, 44, 66, 91	V _{SS}	—	These are power supply (0 V) input pins. For the EVA device, pin 66 is the DV _{SS} supply pin for the high current outputs.
17	C	—	This is the power supply stabilization capacitor pin. It should be connected to higher than or equal to 0.1 μ F ceramic capacitor.

MB90945 Series

■ I/O CIRCUIT TYPE

Type	Circuit	Remarks
A		Oscillation feedback resistor : 1 MΩ approx.
B		CMOS Hysteresis input with pull-up resistor : 50 kΩ approx.
C		- EVA/ROM device : CMOS Hysteresis input - Flash device : CMOS input.
D		- CMOS output (4 mA) - Automotive Hysteresis input

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Type	Circuit	Remarks
E	The diagram shows a CMOS output stage with a PMOS transistor (Pch) connected to Vcc and an NMOS transistor (Nch) connected to ground. The output of the stage is connected to an Analog input and an Automotive Hysteresis input through a resistor R.	• CMOS output (4 mA) • Automotive Hysteresis input • Analog input
F	The diagram shows a CMOS output stage with a PMOS transistor (Pch) connected to Vcc and an NMOS transistor (Nch) connected to ground. The output of the stage is connected to a CMOS Hysteresis input through a resistor R.	• CMOS output P42, P43 : 3mA P21 : 4 mA • CMOS Hysteresis input
G	The diagram shows a CMOS input stage with a pull-down resistor R connected to ground. The input is connected to a CMOS Hysteresis input through a resistor R.	• EVA/ROM device : CMOS Hysteresis input with pull-down resistor : 50 kΩ approx. • Flash device : CMOS input without pull-down.
H	The diagram shows a CMOS output stage with a PMOS transistor (Pch) connected to Vcc and an NMOS transistor (Nch) connected to ground. The output of the stage is connected to an Automotive Hysteresis input through a resistor R.	• EVA/ROM device : CMOS high current output (30 mA) with slewrate control • Flash device : CMOS output (4 mA) • Automotive Hysteresis input

■ HANDLING DEVICES

Special care is required for the following when handling the device :

- Preventing latch-up
- Stabilization of supply voltage
- Treatment of unused pins
- Using external clock
- Power supply pins (V_{CC}/V_{SS})
- Pull-up/pull-down resistors
- Crystal Oscillator Circuit
- Turning-on Sequence of Power Supply to A/D Converter and Analog Inputs
- Connection of Unused Pins of A/D Converter if A/D Converter is unused.
- Caution on Operations during PLL Clock Mode

1. Preventing latch-up

CMOS IC chips may suffer latch-up under the following conditions :

- A voltage higher than V_{CC} or lower than V_{SS} is applied to an input or output pin.
- A voltage higher than the rated voltage is applied between V_{CC} and V_{SS} .
- The AV_{CC} power supply is applied before the V_{CC} voltage.

Latch-up may increase the power supply current drastically, causing thermal damage to the device.

In using the devices, take sufficient care to avoid exceeding maximum ratings.

For the same reason, also be careful not to let the analog power-supply voltage (AV_{CC} , AV_{RH}) exceed the digital power-supply voltage.

2. Stabilization of supply voltage

A sudden change in the supply voltage may cause the device to malfunction even within the specified V_{CC} supply voltage operation range. Therefore, the V_{CC} supply voltage should be stabilized.

For reference, the supply voltage should be controlled so that V_{CC} ripple variations (peak-to-peak values) at commercial frequencies (50 Hz to 60 Hz) fall below 10 % of the standard V_{CC} supply voltage and the coefficient of fluctuation does not exceed 0.1 V/ms at instantaneous power switching.

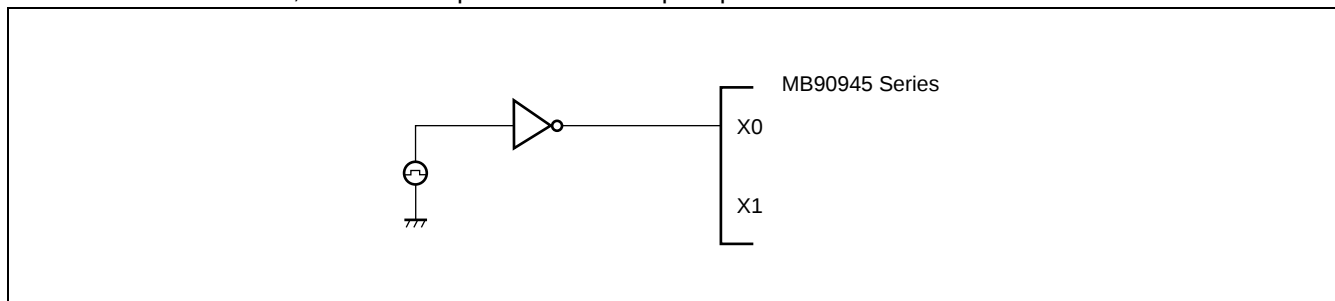
3. Treatment of unused pins

Leaving unused input pins open may result in misbehavior or latch up and possible permanent damage of the device. Therefore they must be pulled up or pulled down through resistors. In this case those resistors should be more than 2 k Ω .

Unused bidirectional pins should be set to the output state and can be left open, or the input state with the above described connection.

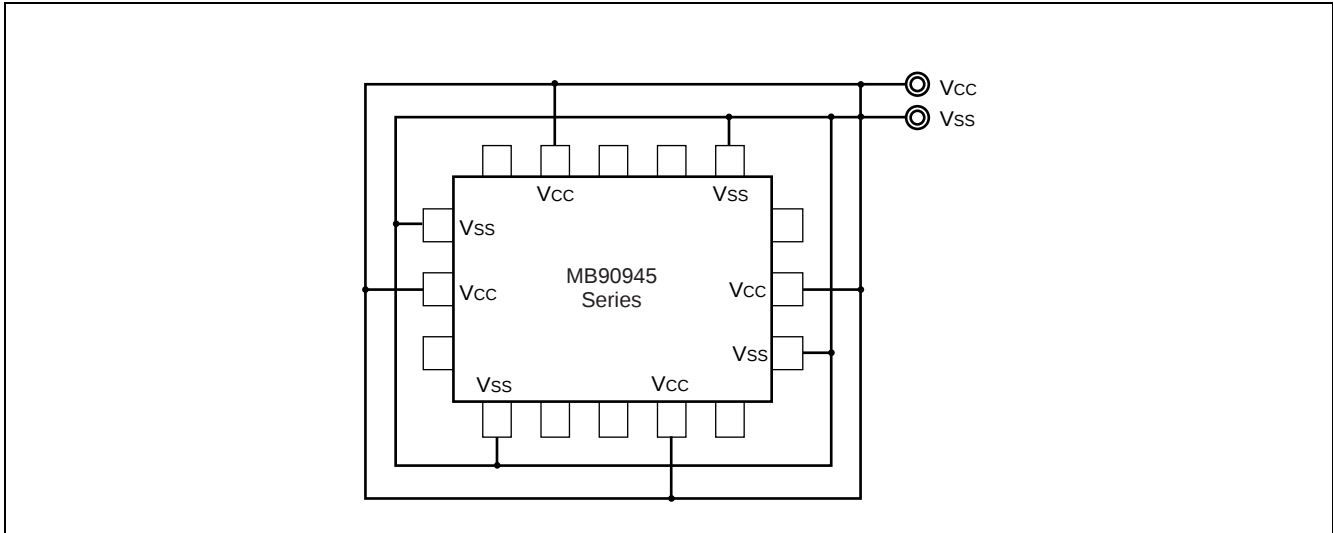
4. Using external clock

To use external clock, drive the X0 pin and leave X1 pin open.



5. Power supply pins (V_{CC}/V_{SS})

- If there are multiple V_{CC} and V_{SS} pins, from the point of view of device design, pins to be of the same potential are connected the inside of the device to prevent such malfunctioning as latch up.
To reduce unnecessary radiation, prevent malfunctioning of the strobe signal due to the rise of ground level, and observe the standard for total output current, be sure to connect the V_{CC} and V_{SS} pins to the power supply and ground externally.
- Connect V_{CC} and V_{SS} to the device from the current supply source at a low impedance.
- As a measure against power supply noise, connect a capacitor of about 0.1 μF as a bypass capacitor between V_{CC} and V_{SS} in the vicinity of V_{CC} and V_{SS} pins of the device.



6. Pull-up/pull-down resistors

The MB90945 series does not support internal pull-up/pull-down resistors option. Use external components where needed.

7. Crystal Oscillator Circuit

Noises around X0 or X1 pins may be possible causes of abnormal operations. Make sure to provide bypass capacitors via shortest distance from X0, X1 pins, crystal oscillator (or ceramic oscillator) and ground lines, and make sure, to the utmost effort, that lines of oscillation circuit not cross the lines of other circuits while you design a printed circuit.

It is highly recommended to provide a printed circuit board art work surrounding X0 and X1 pins with a ground area for stabilizing the operation.

8. Turning-on Sequence of Power Supply to A/D Converter and Analog Inputs

Make sure to turn on the A/D converter power supply (AV_{CC} , AV_{RH} , AV_{RL}) and analog inputs ($AN0$ to $AN14$) after turning-on the digital power supply (V_{CC}).

Turn-off the digital power after turning off the A/D converter supply and analog inputs. In this case, make sure that the voltage not exceed AV_{RH} or AV_{CC} (turning on/off the analog and digital power supplies simultaneously is acceptable).

9. Connection of Unused Pins of A/D Converter if A/D Converter is unused

Connect unused pins of A/D converter to $AV_{CC} = V_{CC}$, $AV_{SS} = AV_{RH} = AV_{RL} = V_{SS}$.

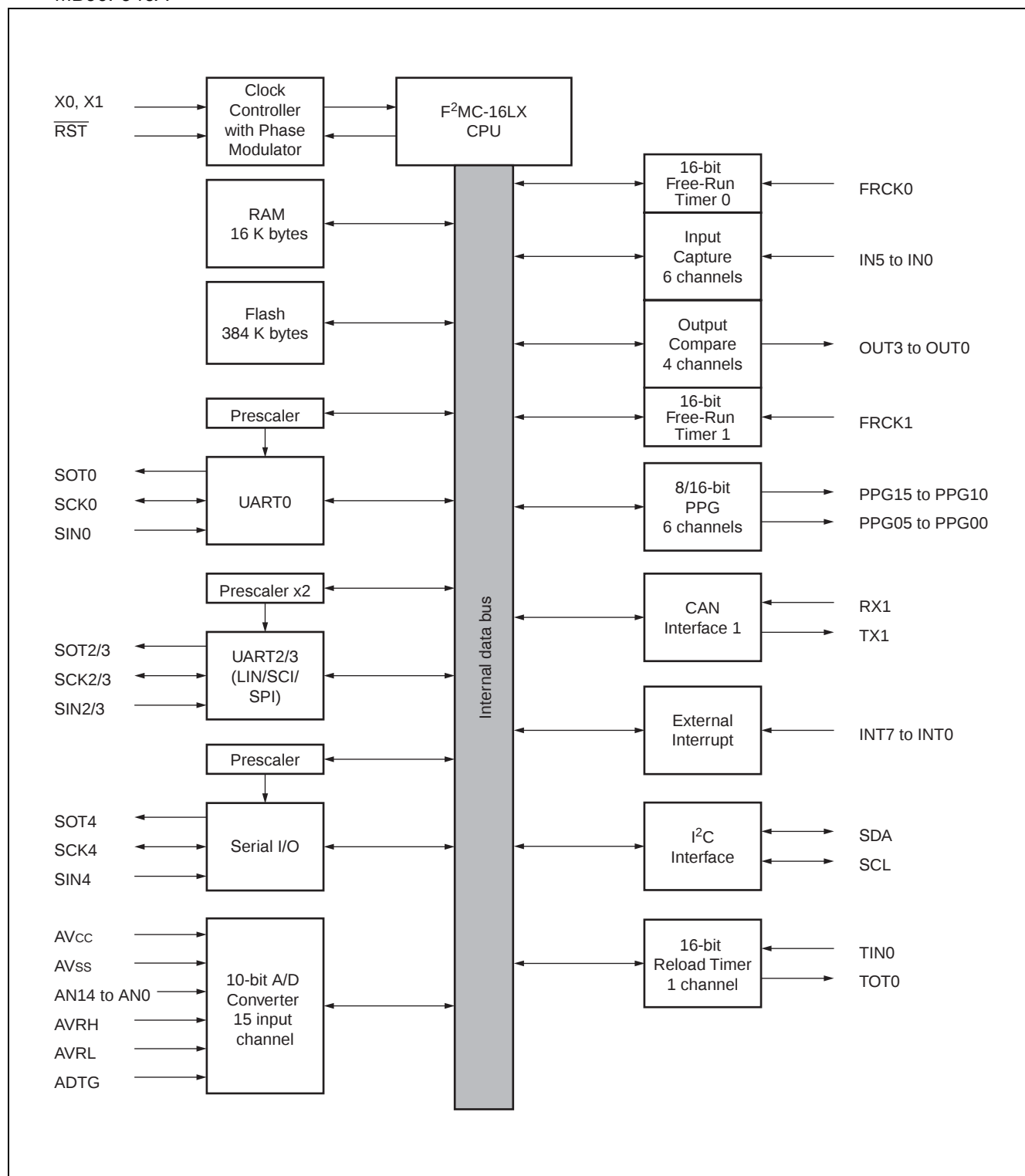
10. Notes on During Operation of PLL Clock Mode

If the PLL clock mode is selected, the microcontroller attempt to be working with the self-oscillating circuit even when there is no external oscillator or external clock input is stopped. Performance of this operation, however, cannot be guaranteed.

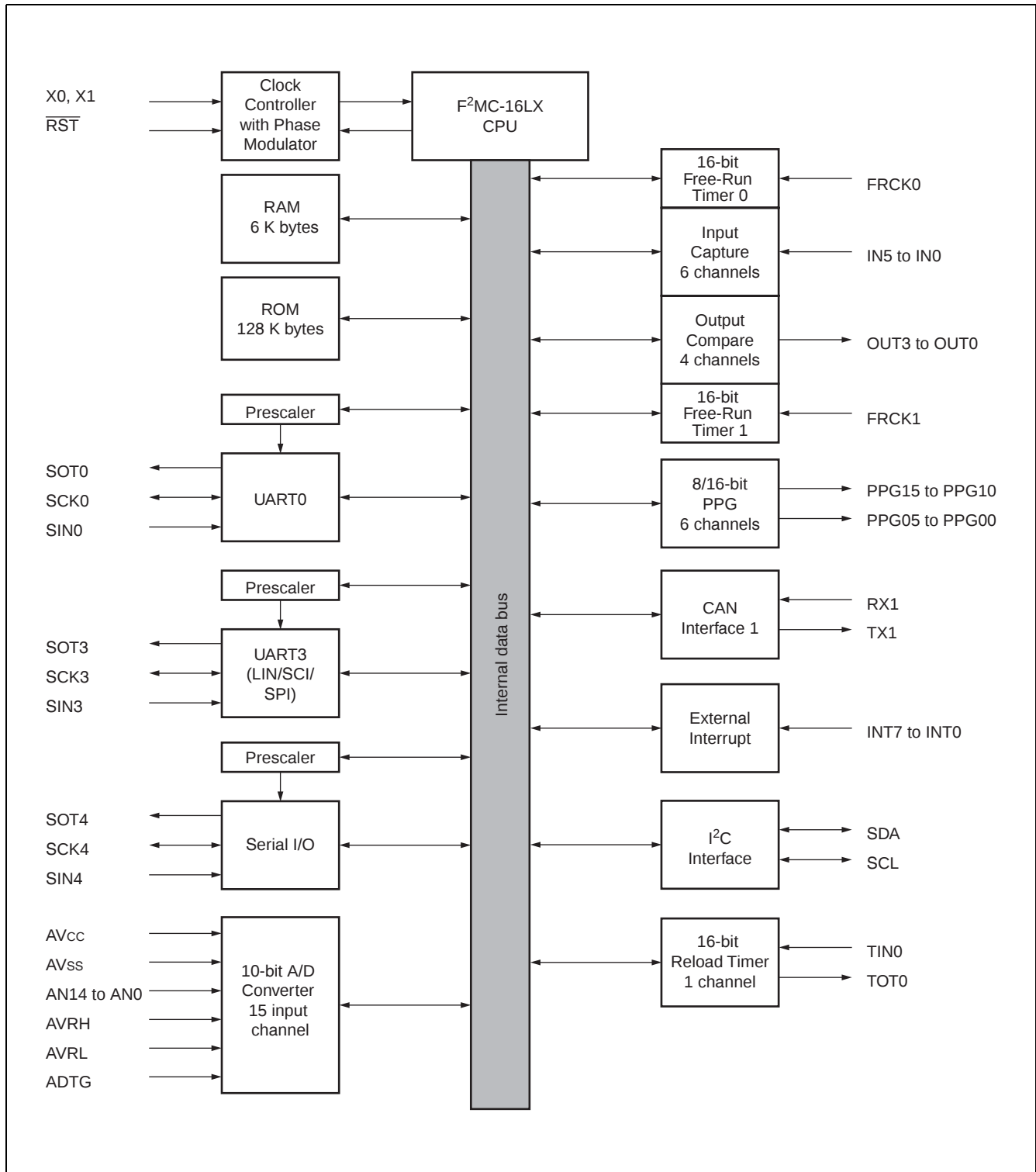
MB90945 Series

■ BLOCK DIAGRAMS

• MB90F946A

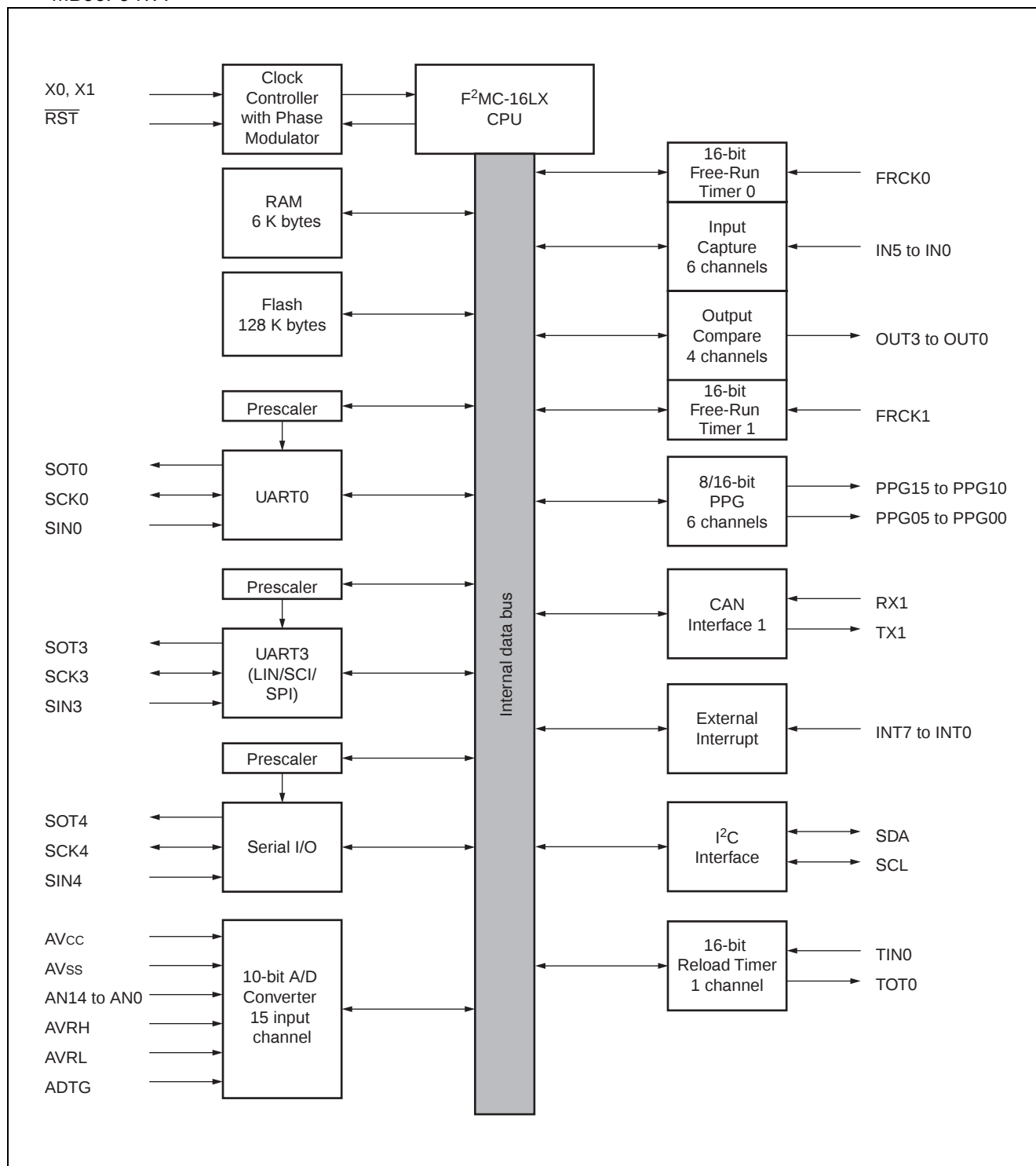


• MB90947A

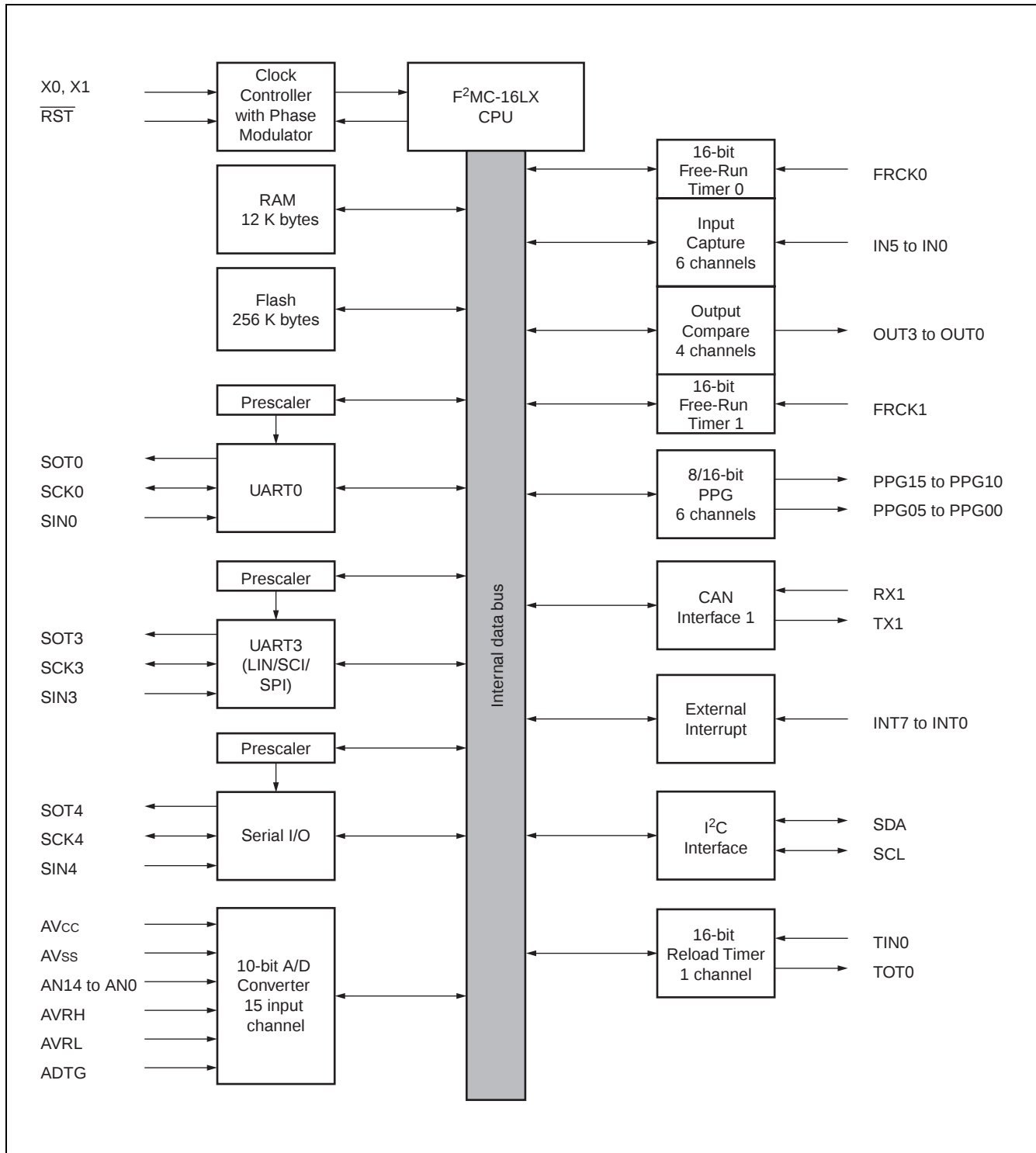


MB90945 Series

• MB90F947A

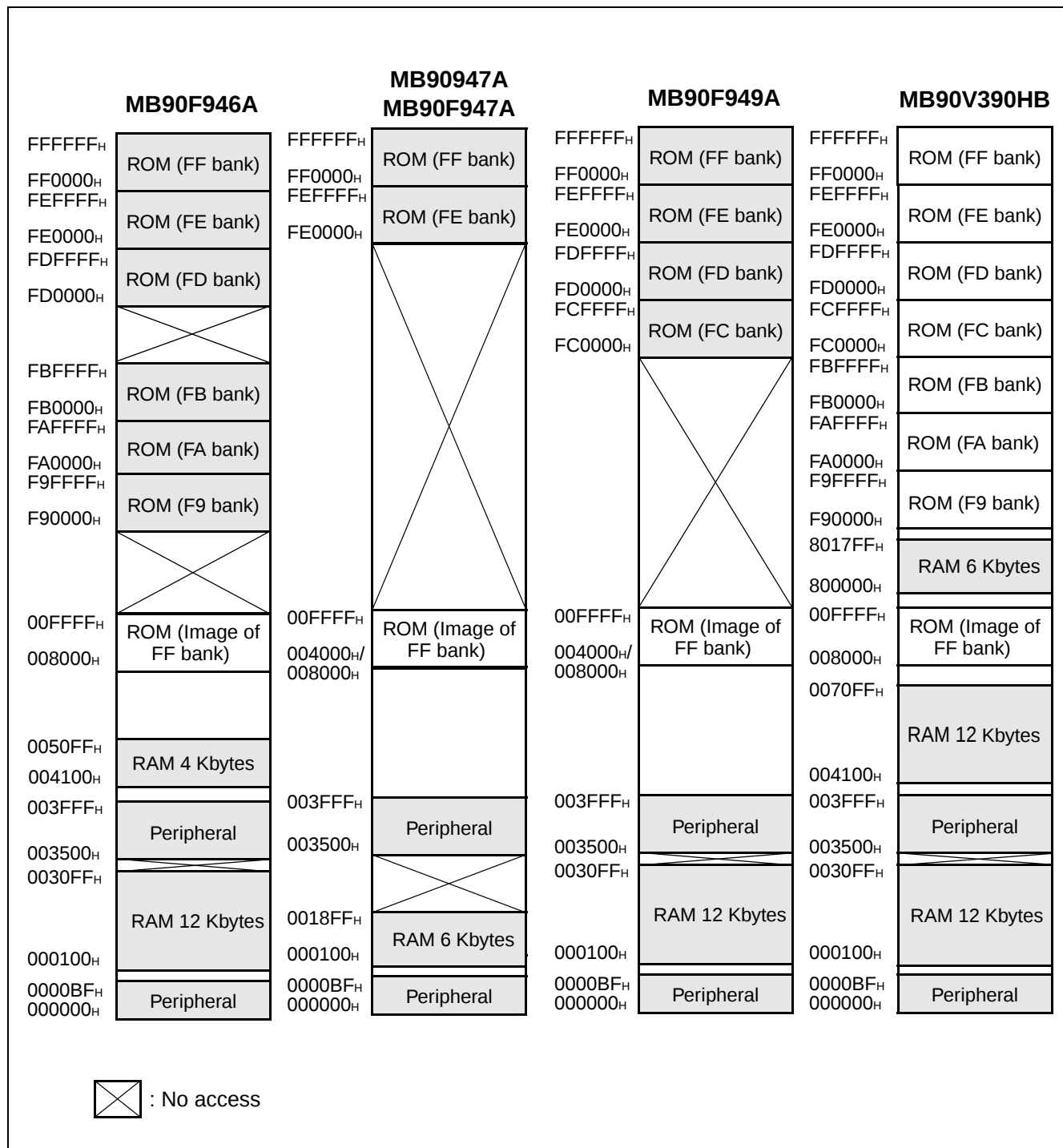


• MB90F949A



MB90945 Series

■ MEMORY MAP



Note : The high-order portion of bank 00 gives the image of the FF bank ROM to make the small model of the C compiler effective. Since the low-order 16 bits are the same, the table in ROM can be referenced without using the far specification in the pointer declaration.

For example, an attempt to access 00C000_H accesses the value at FFC000_H in ROM.

The ROM area in bank FF exceeds 32/48 K bytes, and its entire image cannot be shown in bank 00.

The image between FF4000_H/FF8000_H and FFFFFFF_H is visible in bank 00, while the image between FF0000_H and FF3FFF_H/FF7FFF_H is visible only in bank FF.

■ I/O MAP

Address	Register	Abbrevia- tion	Access	Resource name	Initial value
00 _H	Port 0 data register	PDR0	R/W	Port 0	XXXXXXXX
01 _H	Port 1 data register	PDR1	R/W	Port 1	XXXXXXXX
02 _H	Port 2 data register	PDR2	R/W	Port 2	XXXXXXXX
03 _H	Port 3 data register	PDR3	R/W	Port 3	XXXXXXXX
04 _H	Port 4 data register	PDR4	R/W	Port 4	XXXXXXXX
05 _H	Port 5 data register	PDR5	R/W	Port 5	XXXXXXXX
06 _H	Port 6 data register	PDR6	R/W	Port 6	XXXXXXXX
07 _H	Reserved				
08 _H	Port 8 data register	PDR8	R/W	Port 8	XXXXXXXX
09 _H	Port 9 data register	PDR9	R/W	Port 9	XXXXXXXX
0A _H	Port A data register	PDRA	R/W	Port A	XXXXXXXX
0B _H	Port B data register	PDRB	R/W	Port B	XXXXXXXX
0C _H	Analog input enable register 0	ADER0	R/W	Port 6, A/D	11111111
0D _H	Analog input enable register 1/ ADC select	ADER1	R/W	Port B, A/D	01111111
0E _H	Input level select register (MB90V390HB only)	ILSR	R/W	Ports	00000000
0F _H	Input level select register (MB90V390HB only)	ILSR	R/W	Ports	00000000
10 _H	Port 0 direction register	DDR0	R/W	Port 0	00000000
11 _H	Port 1 direction register	DDR1	R/W	Port 1	00000000
12 _H	Port 2 direction register	DDR2	R/W	Port 2	00000000
13 _H	Port 3 direction register	DDR3	R/W	Port 3	00000000
14 _H	Port 4 direction register	DDR4	R/W	Port 4	00000000
15 _H	Port 5 direction register	DDR5	R/W	Port 5	00000000
16 _H	Port 6 direction register	DDR6	R/W	Port 6	00000000
17 _H	Reserved				
18 _H	Port 8 direction register	DDR8	R/W	Port 8	XXXXXX00
19 _H	Port 9 direction register	DDR9	R/W	Port 9	00000000
1A _H	Port A direction register	DDRA	R/W	Port A	00000000
1B _H	Port B direction register	DDRB	R/W	Port B	00000000
1C _H to 1F _H	Reserved				

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MB90945 Series

Address	Register	Abbrevia- tion	Access	Resource name	Initial value
20 _H	Serial mode control register 0	UMC0	R/W	UART0	00000100
21 _H	Status register 0	USR0	R/W		00010000
22 _H	Input/output data register 0	UIDR0/ UODR0	R/W		XXXXXXXX
23 _H	Rate and data register 0	URD0	R/W		0000000X
24 _H to 2B _H	Reserved				
2C _H	Serial mode control register 4	SMCS4	R/W	Serial I/O Interface	XXXX0000
2D _H	Serial mode control register 4	SMCS4	R/W		00000010
2E _H	Serial data register 4	SDR4	R/W		XXXXXXXX
2F _H	Serial I/O prescaler/edge selector register 4	CDCR4	R/W		0 X 0 X 0000
30 _H	External interrupt enable register	ENIR	R/W	External Interrupt	00000000
31 _H	External interrupt request register	EIRR	R/W		XXXXXXXX
32 _H	External interrupt level register	ELVR	R/W		00000000
33 _H	External interrupt level register	ELVR	R/W		00000000
34 _H	A/D control status register 0	ADCS0	R/W	A/D Converter	00000000
35 _H	A/D control status register 1	ADCS1	R/W		00000000
36 _H	A/D data register 0	ADCR0	R		XXXXXXXX
37 _H	A/D data register 1	ADCR1	R/W		000000XX
38 _H	PPG0 operation mode control register	PPGC0	R/W	16-bit Programmable Pulse Generator 0/1	0X000XX1
39 _H	PPG1 operation mode control register	PPGC1	R/W		0X000001
3A _H	PPG0 and PPG1 clock select register	PPG01	R/W		000000XX
3B _H	Reserved				
3C _H	PPG2 operation mode control register	PPGC2	R/W	16-bit Programmable Pulse Generator 2/3	0X000XX1
3D _H	PPG3 operation mode control register	PPGC3	R/W		0X000001
3E _H	PPG2 and PPG3 clock select register	PPG23	R/W		000000XX
3F _H	Reserved				
40 _H	PPG4 operation mode control register	PPGC4	R/W	16-bit Programmable Pulse Generator 4/5	0X000XX1
41 _H	PPG5 operation mode control register	PPGC5	R/W		0X000001
42 _H	PPG4 and PPG5 clock select register	PPG45	R/W		000000XX
43 _H	Reserved				
44 _H	PPG6 operation mode control register	PPGC6	R/W	16-bit Programmable Pulse Generator 6/7	0X000XX1
45 _H	PPG7 operation mode control register	PPGC7	R/W		0X000001
46 _H	PPG6 and PPG7 clock select register	PPG67	R/W		000000XX
47 _H	Reserved				

(Continued)

MB90945 Series

Address	Register	Abbrevia- tion	Access	Resource name	Initial value
48 _H	PPG8 operation mode control register	PPGC8	R/W	16-bit Programable Pulse Generator 8/9	0X000XX1
49 _H	PPG9 operation mode control register	PPGC9	R/W		0X000001
4A _H	PPG8 and PPG9 clock select register	PPG89	R/W		000000XX
4B _H	Reserved				
4C _H	PPGA operation mode control register	PPGCA	R/W	16-bit Programable Pulse Generator A/B	0X000XX1
4D _H	PPGB operation mode control register	PPGCB	R/W		0X000001
4E _H	PPGA and PPGB clock select register	PPGAB	R/W		000000XX
4F _H	Reserved				
50 _H	Timer control status register 0	TMCSR0	R/W	16-bit Reload Timer 0	00000000
51 _H	Timer control status register 0	TMCSR0	R/W		XXXX0000
52 _H to 53 _H	Reserved				
54 _H	Input capture control status register 0/1	ICS01	R/W	Input Capture 0/1	00000000
55 _H	Input capture control status register 2/3	ICS23	R/W	Input Capture 2/3	00000000
56 _H	Input capture control status register 4/5	ICS45	R/W	Input Capture 4/5	00000000
57 _H	Reserved				
58 _H	Output compare control status register 0	OCS0	R/W	Output Compare 0/1	0000XX00
59 _H	Output compare control status register 1	OCS1	R/W		0XX00000
5A _H	Output compare control status register 2	OCS2	R/W	Output Compare 2/3	0000XX00
5B _H	Output compare control status register 3	OCS3	R/W		0XX00000
5C _H to 6E _H	Reserved				
6F _H	ROM Mirror	ROMM	W	ROM Mirror	XXXXXXXX1
70 _H to 7F _H	Reserved				
80 _H to 8F _H	Reserved for CAN interface 1. Refer to “■ CAN CONTROLLER”				
90 _H to 9D _H	Reserved				
9E _H	ROM correction control status register 0	PACSR0	R/W	ROM Correction 0	00000000
9F _H	Delayed interrupt/release register	DIRR	R/W	Delayed Interrupt	XXXXXXXX0
A0 _H	Low-power consumption mode control register	LPMCR	R/W	Low Power Controller	00011000
A1 _H	Clock selector register	CKSCR	R/W	Low Power Controller	11111100
A2 _H to A7 _H	Reserved				
A8 _H	Watchdog control register	WDTC	R/W	Watchdog Timer	XXXXX111
A9 _H	Timebase timer control register	TBTC	R/W	Timebase timer	1XX00100
AA _H to AD _H	Reserved				

(Continued)

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Address	Register	Abbrevia- tion	Access	Resource name	Initial value
AE _H	Flash control status register (Flash devices only. Otherwise reserved)	FMCS	R/W	Flash memory	000X0000
AF _H	Reserved				
B0 _H	Interrupt control register 00	ICR00	R/W	Interrupt controller	00000111
B1 _H	Interrupt control register 01	ICR01	R/W		00000111
B2 _H	Interrupt control register 02	ICR02	R/W		00000111
B3 _H	Interrupt control register 03	ICR03	R/W		00000111
B4 _H	Interrupt control register 04	ICR04	R/W		00000111
B5 _H	Interrupt control register 05	ICR05	R/W		00000111
B6 _H	Interrupt control register 06	ICR06	R/W		00000111
B7 _H	Interrupt control register 07	ICR07	R/W		00000111
B8 _H	Interrupt control register 08	ICR08	R/W		00000111
B9 _H	Interrupt control register 09	ICR09	R/W		00000111
BA _H	Interrupt control register 10	ICR10	R/W		00000111
BB _H	Interrupt control register 11	ICR11	R/W		00000111
BC _H	Interrupt control register 12	ICR12	R/W		00000111
BD _H	Interrupt control register 13	ICR13	R/W		00000111
BE _H	Interrupt control register 14	ICR14	R/W		00000111
BF _H	Interrupt control register 15	ICR15	R/W		00000111
C0 _H to FF _H	Reserved				

(Continued)

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Address	Register	Abbrevia- tion	Access	Resource name	Initial value
3500 _H	Reload register L	PRLLO	R/W	16-bit Programable Pulse Generator 0/1	XXXXXXXX
3501 _H	Reload register H	PRLH0	R/W		XXXXXXXX
3502 _H	Reload register L	PRLLO1	R/W		XXXXXXXX
3503 _H	Reload register H	PRLH1	R/W		XXXXXXXX
3504 _H	Reload register L	PRLLO2	R/W	16-bit Programable Pulse Generator 2/3	XXXXXXXX
3505 _H	Reload register H	PRLH2	R/W		XXXXXXXX
3506 _H	Reload register L	PRLLO3	R/W		XXXXXXXX
3507 _H	Reload register H	PRLH3	R/W		XXXXXXXX
3508 _H	Reload register L	PRLLO4	R/W	16-bit Programable Pulse Generator 4/5	XXXXXXXX
3509 _H	Reload register H	PRLH4	R/W		XXXXXXXX
350A _H	Reload register L	PRLLO5	R/W		XXXXXXXX
350B _H	Reload register H	PRLH5	R/W		XXXXXXXX
350C _H	Reload register L	PRLLO6	R/W	16-bit Programable Pulse Generator 6/7	XXXXXXXX
350D _H	Reload register H	PRLH6	R/W		XXXXXXXX
350E _H	Reload register L	PRLLO7	R/W		XXXXXXXX
350F _H	Reload register H	PRLH7	R/W		XXXXXXXX
3510 _H	Reload register L	PRLLO8	R/W	16-bit Programable Pulse Generator 8/9	XXXXXXXX
3511 _H	Reload register H	PRLH8	R/W		XXXXXXXX
3512 _H	Reload register L	PRLLO9	R/W		XXXXXXXX
3513 _H	Reload register H	PRLH9	R/W		XXXXXXXX
3514 _H	Reload register L	PRLLOA	R/W	16-bit Programable Pulse Generator A/B	XXXXXXXX
3515 _H	Reload register H	PRLHA	R/W		XXXXXXXX
3516 _H	Reload register L	PRLLOB	R/W		XXXXXXXX
3517 _H	Reload register H	PRLHB	R/W		XXXXXXXX
3518 _H	Serial mode register	SMR3	R/W	UART3	00000000
3519 _H	Serial control register	SCR3	R/W		00000000
351A _H	Reception/transmission data register	RDR3/ TDR3	R/W		00000000
351B _H	Serial status register	SSR3	R/W		00001000
351C _H	Extended communication control reg.	ECCR3	R/W		000000XX
351D _H	Extended status/control register	ESCR3	R/W		00000100
351E _H	Baud rate register 0	BGR03	R/W		00000000
351F _H	Baud rate register 1	BGR13	R/W		00000000

(Continued)

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Address	Register	Abbrevia- tion	Access	Resource name	Initial value
3520 _H	Input capture register 0	IPCP0	R	Input Capture 0/1	XXXXXXXX
3521 _H	Input capture register 0	IPCP0	R		XXXXXXXX
3522 _H	Input capture register 1	IPCP1	R		XXXXXXXX
3523 _H	Input capture register 1	IPCP1	R		XXXXXXXX
3524 _H	Input capture register 2	IPCP2	R	Input Capture 2/3	XXXXXXXX
3525 _H	Input capture register 2	IPCP2	R		XXXXXXXX
3526 _H	Input capture register 3	IPCP3	R		XXXXXXXX
3527 _H	Input capture register 3	IPCP3	R		XXXXXXXX
3528 _H	Input capture register 4	IPCP4	R	Input Capture 4/5	XXXXXXXX
3529 _H	Input capture register 4	IPCP4	R		XXXXXXXX
352A _H	Input capture register 5	IPCP5	R		XXXXXXXX
352B _H	Input capture register 5	IPCP5	R		XXXXXXXX
352C _H	Timer data register 0	TCDT0	R/W	16-bit Free-Run Timer 0	00000000
352D _H	Timer data register 0	TCDT0	R/W		00000000
352E _H	Timer control register 0	TCCS0	R/W		00000000
352F _H	Timer control register 0	TCCS0	R/W		0XXXXXXXX
3530 _H	Output compare register 0	OCCP0	R/W	Output Compare 0/1	XXXXXXXX
3531 _H	Output compare register 0	OCCP0	R/W		XXXXXXXX
3532 _H	Output compare register 1	OCCP1	R/W		XXXXXXXX
3533 _H	Output compare register 1	OCCP1	R/W		XXXXXXXX
3534 _H	Output compare register 2	OCCP2	R/W	Output Compare 2/3	XXXXXXXX
3535 _H	Output compare register 2	OCCP2	R/W		XXXXXXXX
3536 _H	Output compare register 3	OCCP3	R/W		XXXXXXXX
3537 _H	Output compare register 3	OCCP3	R/W		XXXXXXXX
3538 _H to 353B _H	Reserved				
353C _H	Timer data register 1	TCDT1	R/W	16-bit Free-Run Timer 1	00000000
353D _H	Timer data register 1	TCDT1	R/W		00000000
353E _H	Timer control register 1	TCCS1	R/W		00000000
353F _H	Timer control register 1	TCCS1	R/W		0XXXXXXXX
3540 _H	Timer register 0/Reload register 0	TMR0/ TMRLR0	R/W	16-bit Reload Timer 0	XXXXXXXX
3541 _H	Timer register 0/Reload register 0	TMR0/ TMRLR0	R/W		XXXXXXXX
3542 _H to 356D _H	Reserved				

(Continued)

Address	Register	Abbrevia- tion	Access	Resource name	Initial value
356E _H	CAN direct mode register	CDMR	R/W	CAN clock sync	XXXXXXX0
356F _H to 359F _H	Reserved				
35A0 _H	I ² C bus status register	IBSR	R	I ² C Interface	00000000
35A1 _H	I ² C bus control register	IBCR	R/W		00000000
35A2 _H	I ² C ten bit slave address register	ITBAL	R/W		00000000
35A3 _H		ITBAH	R/W		00000000
35A4 _H	I ² C ten bit address mask register	ITMKL	R/W		11111111
35A5 _H		ITMKH	R/W		00111111
35A6 _H	I ² C seven bit slave address register	ISBA	R/W		00000000
35A7 _H	I ² C seven bit address mask register	ISMK	R/W		01111111
35A8 _H	I ² C data register	IDAR	R/W		00000000
35A9 _H to 35AA _H	Reserved				
35AB _H	I ² C clock control register	ICCR	R/W	I ² C Interface	00011111
35AC _H to 35C8 _H	Reserved				
35C9 _H	Input capture edge 0/1	ICE01	R/W	Input Capture 0/1	XXXXX0XX
35CA _H	Input capture edge 2/3	ICE23	R	Input Capture 2/3	XXXXXXXXXX
35CB _H	Input capture edge 4/5	ICE45	R/W	Input Capture 4/5	XXXXX0XX
35CC _H to 35CE _H	Reserved				
35CF _H	PLL and special configuration control register	PSCCR	W	PLL	XXXX0000
35D0 _H to 35D7 _H	Reserved				
35D8 _H	Serial mode register	SMR2	R/W	UART2 (MB90V390HB and MB90F946A only)	00000000
35D9 _H	Serial control register	SCR2	R/W		00000000
35DA _H	Reception/transmission data register	RDR2/ TDR2	R/W		00000000
35DB _H	Serial status register	SSR2	R/W		00001000
35DC _H	Extended communication control reg.	ECCR2	R/W		000000XX
35DD _H	Extended status/control register	ESCR2	R/W		00000100
35DE _H	Baud rate register 0	BGR02	R/W		00000000

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Address	Register	Abbrevia- tion	Access	Resource name	Initial value
35DF _H	Baud rate register 1	BGR12	R/W	UART2 (MB90V390HB and MB90F946A only)	00000000
35E0 _H	ROM correction address register 0	PADR0	R/W	Address Matching Detection Function 0	XXXXXXXX
35E1 _H	ROM correction address register 0	PADR0	R/W		XXXXXXXX
35E2 _H	ROM correction address register 0	PADR0	R/W		XXXXXXXX
35E3 _H	ROM correction address register 1	PADR1	R/W		XXXXXXXX
35E4 _H	ROM correction address register 1	PADR1	R/W		XXXXXXXX
35E5 _H	ROM correction address register 1	PADR1	R/W		XXXXXXXX
35E6 _H	ROM correction address register 2	PADR2	R/W	Address Matching Detection Function 0	XXXXXXXX
35E7 _H	ROM correction address register 2	PADR2	R/W		XXXXXXXX
35E8 _H	ROM correction address register 2	PADR2	R/W		XXXXXXXX
35E9 _H to 37FF _H	Reserved				
3800 _H to 38FF _H	CAN interface 1. Refer to “■ CAN CONTROLLER”				
3900 _H to 39FF _H	CAN interface 1. Refer to “■ CAN CONTROLLER”				
3A00 _H to 3FFF _H	Reserved				

_ : Unused bit

X : Unknown value

Note : Any write access to reserved addresses in I/O map should not be performed.
A read access to reserved address results in reading “X”.

■ CAN CONTROLLER

The CAN controller has the following features :

- Conforms to CAN Specification Version 2.0 Part A and B
 - Supports transmission/reception in standard frame and extended frame formats
- Supports transmitting of data frames by receiving remote frames
- 16 transmitting/receiving message buffers
 - 29-bit ID and 8-byte data
 - Multi-level message buffer configuration
- Provides full-bit comparison, full-bit mask, acceptance mask register 0/acceptance mask register 1 for each message buffer as ID acceptance mask
 - Two acceptance mask registers in either standard frame format or extended frame formats
- Bit rate programmable from 10 Kbps to 2 Mbps (when input clock is at 16 MHz)

List of Control Registers (1)

Address	Register	Abbreviation	Access	Initial Value
CAN1				
000080 _H	Message buffer valid register	BVALR	R/W	00000000 00000000
000081 _H				
000082 _H	Transmit request register	TREQR	R/W	00000000 00000000
000083 _H				
000084 _H	Transmit cancel register	TCANR	W	00000000 00000000
000085 _H				
000086 _H	Transmit complete register	TCR	R/W	00000000 00000000
000087 _H				
000088 _H	Receive complete register	RCR	R/W	00000000 00000000
000089 _H				
00008A _H	Remote request receiving register	RRTRR	R/W	00000000 00000000
00008B _H				
00008C _H	Receive overrun register	ROVRR	R/W	00000000 00000000
00008D _H				
00008E _H	Receive interrupt enable register	RIER	R/W	00000000 00000000
00008F _H				

List of Control Registers (2)

Address	Register	Abbreviation	Access	Initial Value
CAN1				
003900 _H	Control status register	CSR	R/W, R	00XXX000 0XXXX0X1
003901 _H				
003902 _H	Last event indicator register	LEIR	R/W	XXXXXXXX 000X0000
003903 _H				
003904 _H	Receive/transmit error counter	RTEC	R	00000000 00000000
003905 _H				
003906 _H	Bit timing register	BTR	R/W	X1111111 11111111
003907 _H				
003908 _H	IDE register	IDER	R/W	XXXXXXXX XXXXXXXX
003909 _H				
00390A _H	Transmit RTR register	TRTRR	R/W	00000000 00000000
00390B _H				
00390C _H	Remote frame receive waiting register	RFWTR	R/W	XXXXXXXX XXXXXXXX
00390D _H				
00390E _H	Transmit interrupt enable register	TIER	R/W	00000000 00000000
00390F _H				
003910 _H	Acceptance mask select register	AMSR	R/W	XXXXXXXX XXXXXXXX
003911 _H				XXXXXXXX XXXXXXXX
003912 _H				
003913 _H				
003914 _H	Acceptance mask register 0	AMR0	R/W	XXXXXXXX XXXXXXXX
003915 _H				XXXXXXXX XXXXXXXX
003916 _H				
003917 _H				
003918 _H	Acceptance mask register 1	AMR1	R/W	XXXXXXXX XXXXXXXX
003919 _H				XXXXXXXX XXXXXXXX
00391A _H				
00391B _H				

List of Message Buffers (ID Registers) (1)

Address	Register	Abbreviation	Access	Initial Value
CAN1				
003800 _H to 00381F _H	General- purpose RAM	—	R/W	XXXXXXXX to XXXXXXXX
003820 _H	ID register 0	IDR0	R/W	XXXXXXXX XXXXXXXX
003821 _H				XXXXXXXX XXXXXXXX
003822 _H				XXXXXXXX XXXXXXXX
003823 _H				XXXXXXXX XXXXXXXX
003824 _H	ID register 1	IDR1	R/W	XXXXXXXX XXXXXXXX
003825 _H				XXXXXXXX XXXXXXXX
003826 _H				XXXXXXXX XXXXXXXX
003827 _H				XXXXXXXX XXXXXXXX
003828 _H	ID register 2	IDR2	R/W	XXXXXXXX XXXXXXXX
003829 _H				XXXXXXXX XXXXXXXX
00382A _H				XXXXXXXX XXXXXXXX
00382B _H				XXXXXXXX XXXXXXXX
00382C _H	ID register 3	IDR3	R/W	XXXXXXXX XXXXXXXX
00382D _H				XXXXXXXX XXXXXXXX
00382E _H				XXXXXXXX XXXXXXXX
00382F _H				XXXXXXXX XXXXXXXX
003830 _H	ID register 4	IDR4	R/W	XXXXXXXX XXXXXXXX
003831 _H				XXXXXXXX XXXXXXXX
003832 _H				XXXXXXXX XXXXXXXX
003833 _H				XXXXXXXX XXXXXXXX
003834 _H	ID register 5	IDR5	R/W	XXXXXXXX XXXXXXXX
003835 _H				XXXXXXXX XXXXXXXX
003836 _H				XXXXXXXX XXXXXXXX
003837 _H				XXXXXXXX XXXXXXXX
003838 _H	ID register 6	IDR6	R/W	XXXXXXXX XXXXXXXX
003839 _H				XXXXXXXX XXXXXXXX
00383A _H				XXXXXXXX XXXXXXXX
00383B _H				XXXXXXXX XXXXXXXX
00383C _H	ID register 7	IDR7	R/W	XXXXXXXX XXXXXXXX
00383D _H				XXXXXXXX XXXXXXXX
00383E _H				XXXXXXXX XXXXXXXX
00383F _H				XXXXXXXX XXXXXXXX

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List of Message Buffers (ID Registers) (2)

Address	Register	Abbreviation	Access	Initial Value
CAN1				
003840 _H	ID register 8	IDR8	R/W	XXXXXXXX XXXXXXXX
003841 _H				
003842 _H				XXXXXXXX XXXXXXXX
003843 _H				
003844 _H	ID register 9	IDR9	R/W	XXXXXXXX XXXXXXXX
003845 _H				
003846 _H				XXXXXXXX XXXXXXXX
003847 _H				
003848 _H	ID register 10	IDR10	R/W	XXXXXXXX XXXXXXXX
003849 _H				
00384A _H				XXXXXXXX XXXXXXXX
00384B _H				
00384C _H	ID register 11	IDR11	R/W	XXXXXXXX XXXXXXXX
00384D _H				
00384E _H				XXXXXXXX XXXXXXXX
00384F _H				
003850 _H	ID register 12	IDR12	R/W	XXXXXXXX XXXXXXXX
003851 _H				
003852 _H				XXXXXXXX XXXXXXXX
003853 _H				
003854 _H	ID register 13	IDR13	R/W	XXXXXXXX XXXXXXXX
003855 _H				
003856 _H				XXXXXXXX XXXXXXXX
003857 _H				
003858 _H	ID register 14	IDR14	R/W	XXXXXXXX XXXXXXXX
003859 _H				
00385A _H				XXXXXXXX XXXXXXXX
00385B _H				
00385C _H	ID register 15	IDR15	R/W	XXXXXXXX XXXXXXXX
00385D _H				
00385E _H				XXXXXXXX XXXXXXXX
00385F _H				

List of Message Buffers (DLC Registers and Data Registers) (1)

Address	Register	Abbreviation	Access	Initial Value
CAN1				
003860 _H	DLC register 0	DLCR0	R/W	XXXXXXXX
003861 _H				
003862 _H	DLC register 1	DLCR1	R/W	XXXXXXXX
003863 _H				
003864 _H	DLC register 2	DLCR2	R/W	XXXXXXXX
003865 _H				
003866 _H	DLC register 3	DLCR3	R/W	XXXXXXXX
003867 _H				
003868 _H	DLC register 4	DLCR4	R/W	XXXXXXXX
003869 _H				
00386A _H	DLC register 5	DLCR5	R/W	XXXXXXXX
00386B _H				
00386C _H	DLC register 6	DLCR6	R/W	XXXXXXXX
00386D _H				
00386E _H	DLC register 7	DLCR7	R/W	XXXXXXXX
00386F _H				
003870 _H	DLC register 8	DLCR8	R/W	XXXXXXXX
003871 _H				
003872 _H	DLC register 9	DLCR9	R/W	XXXXXXXX
003873 _H				
003874 _H	DLC register 10	DLCR10	R/W	XXXXXXXX
003875 _H				
003876 _H	DLC register 11	DLCR11	R/W	XXXXXXXX
003877 _H				
003878 _H	DLC register 12	DLCR12	R/W	XXXXXXXX
003879 _H				
00387A _H	DLC register 13	DLCR13	R/W	XXXXXXXX
00387B _H				
00387C _H	DLC register 14	DLCR14	R/W	XXXXXXXX
00387D _H				
00387E _H	DLC register 15	DLCR15	R/W	XXXXXXXX
00387F _H				

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List of Message Buffers (DLC Registers and Data Registers) (2)

Address	Register	Abbreviation	Access	Initial Value
CAN1				
003880 _H to 003887 _H	Data register 0 (8 bytes)	DTR0	R/W	XXXXXXXX to XXXXXXXX
003888 _H to 00388F _H	Data register 1 (8 bytes)	DTR1	R/W	XXXXXXXX to XXXXXXXX
003890 _H to 003897 _H	Data register 2 (8 bytes)	DTR2	R/W	XXXXXXXX to XXXXXXXX
003898 _H to 00389F _H	Data register 3 (8 bytes)	DTR3	R/W	XXXXXXXX to XXXXXXXX
0038A0 _H to 0038A7 _H	Data register 4 (8 bytes)	DTR4	R/W	XXXXXXXX to XXXXXXXX
0038A8 _H to 0038AF _H	Data register 5 (8 bytes)	DTR5	R/W	XXXXXXXX to XXXXXXXX
0038B0 _H to 0038B7 _H	Data register 6 (8 bytes)	DTR6	R/W	XXXXXXXX to XXXXXXXX
0038B8 _H to 0038BF _H	Data register 7 (8 bytes)	DTR7	R/W	XXXXXXXX to XXXXXXXX
0038C0 _H to 0038C7 _H	Data register 8 (8 bytes)	DTR8	R/W	XXXXXXXX to XXXXXXXX
0038C8 _H to 0038CF _H	Data register 9 (8 bytes)	DTR9	R/W	XXXXXXXX to XXXXXXXX
0038D0 _H to 0038D7 _H	Data register 10 (8 bytes)	DTR10	R/W	XXXXXXXX to XXXXXXXX
0038D8 _H to 0038DF _H	Data register 11 (8 bytes)	DTR11	R/W	XXXXXXXX to XXXXXXXX
0038E0 _H to 0038E7 _H	Data register 12 (8 bytes)	DTR12	R/W	XXXXXXXX to XXXXXXXX
0038E8 _H to 0038EF _H	Data register 13 (8 bytes)	DTR13	R/W	XXXXXXXX to XXXXXXXX

List of Message Buffers (DLC Registers and Data Registers) (3)

Address	Register	Abbreviation	Access	Initial Value
CAN1				
0038F0 _H to 0038F7 _H	Data register 14 (8 bytes)	DTR14	R/W	XXXXXXXX to XXXXXXXX
0038F8 _H to 0038FF _H	Data register 15 (8 bytes)	DTR15	R/W	XXXXXXXX to XXXXXXXX

MB90945 Series

■ INTERRUPT FACTORS, INTERRUPT VECTORS, INTERRUPT CONTROL REGISTER

Interrupt cause	EI ² OS clear	Interrupt vector		Interrupt control register	
		Number	Address	Number	Address
Reset	N/A	#08	FFFFDC _H	—	—
INT9 instruction	N/A	#09	FFFFD8 _H	—	—
Exception	N/A	#10	FFFFD4 _H	—	—
Timebase timer	N/A	#11	FFFFD0 _H	ICR00	0000B0 _H
External Interrupt INT0 to INT7	○	#12	FFFFCC _H		
Reserved	×	#13	FFFFC8 _H	ICR01	0000B1 _H
Reserved	×	#14	FFFFC4 _H		
CAN 1 RX	N/A	#15	FFFFC0 _H	ICR02	0000B2 _H
CAN 1 TX/NS	N/A	#16	FFFFBC _H		
PPG 0/1	N/A	#17	FFFFB8 _H	ICR03	0000B3 _H
PPG 2/3	N/A	#18	FFFFB4 _H		
PPG 4/5	N/A	#19	FFFFB0 _H	ICR04	0000B4 _H
PPG 6/7	N/A	#20	FFFFAC _H		
PPG 8/9	N/A	#21	FFFFA8 _H	ICR05	0000B5 _H
PPG A/B	N/A	#22	FFFFA4 _H		
16-bit Reload Timer 0	○	#23	FFFFA0 _H	ICR06	0000B6 _H
Reserved	×	#24	FFFF9C _H		
Input Capture 0/1	○	#25	FFFF98 _H	ICR07	0000B7 _H
Output compare 0/1	○	#26	FFFF94 _H		
Input Capture 2/3	○	#27	FFFF90 _H	ICR08	0000B8 _H
Output Compare 2/3	○	#28	FFFF8C _H		
Input Capture 4/5	○	#29	FFFF88 _H	ICR09	0000B9 _H
I ² C	○	#30	FFFF84 _H		
A/D Converter	○	#31	FFFF80 _H	ICR10	0000BA _H
16-bit Free-Run Timer 0 / 16-bit Free-Run Timer 1	N/A	#32	FFFF7C _H		
Serial I/O	○	#33	FFFF78 _H	ICR11	0000BB _H
Reserved	×	#34	FFFF74 _H		
UART 0 RX	◎	#35	FFFF70 _H	ICR12	0000BC _H
UART 0 TX	○	#36	FFFF6C _H		
Reserved	×	#37	FFFF68 _H	ICR13	0000BD _H
Reserved	×	#38	FFFF64 _H		

(Continued)

(Continued)

Interrupt cause	EI ² OS clear	Interrupt vector		Interrupt control register	
		Number	Address	Number	Address
UART 2 RX / UART 3 RX	⊙	#39	FFFF60 _H	ICR14	0000BE _H
UART 2 TX / UART 3 TX	○	#40	FFFF5C _H		
Flash memory	N/A	#41	FFFF58 _H	ICR15	0000BF _H
Delayed interrupt	N/A	#42	FFFF54 _H		

○ : The interrupt request flag is cleared by the EI²OS interrupt clear signal.

⊙ : The interrupt request flag is cleared by the EI²OS interrupt clear signal. A stop request is available.

× : Unavailable

N/A : The interrupt request flag is not cleared by the EI²OS interrupt clear signal.

- Notes :
- For a peripheral module with two interrupt causes for a single interrupt number, both interrupt request flags are cleared by the EI²OS interrupt clear signal.
 - At the end of EI²OS, the EI²OS clear signal will be asserted for all the interrupt flags assigned to the same interrupt number. If one interrupt flag starts the EI²OS and in the meantime another interrupt flag is set by hardware event, the later event is lost because the flag is cleared by the EI²OS clear signal caused by the first event. So it is recommended not to use the EI²OS for this interrupt number.
 - If EI²OS is enabled, EI²OS is initiated when one of the two interrupt signals in the same interrupt control register (ICR) is asserted. This means that different interrupt sources share the same EI²OS Descriptor which should be unique for each interrupt source. For this reason, when one interrupt source uses the EI²OS, the other interrupt should be disabled.

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■ ELECTRICAL CHARACTERISTICS

1. Absolute Maximum Ratings

Parameter	Symbol	Rating		Unit	Remarks
		Min	Max		
Power supply voltage*1	V_{CC}	$V_{SS} - 0.3$	$V_{SS} + 6.0$	V	
	AV_{CC}	$V_{SS} - 0.3$	$V_{SS} + 6.0$	V	$V_{CC} = AV_{CC}$ *2
	$AVRH, AVRL$	$V_{SS} - 0.3$	$V_{SS} + 6.0$	V	$AV_{CC} \geq AVRH, AV_{CC} \geq AVRL, AVRH \geq AVRL$
Input voltage*1	V_I	$V_{SS} - 0.3$	$V_{SS} + 6.0$	V	*3
Output voltage*1	V_O	$V_{SS} - 0.3$	$V_{SS} + 6.0$	V	*3
Maximum Clamp Current	I_{CLAMP}	-4.0	+4.0	mA	*5
Total Maximum Clamp Current	$\Sigma I_{CLAMP} $	—	40	mA	*5
"L" level maximum output current	I_{OL1}	—	15	mA	*4
"L" level average output current	I_{OLAV1}	—	4	mA	*4
"L" level maximum overall output current	ΣI_{OL1}	—	100	mA	*4
"L" level average overall output current	ΣI_{OLAV1}	—	50	mA	*4
"H" level maximum output current	I_{OH1}	—	-15	mA	*4
"H" level average output current	I_{OHAV1}	—	-4	mA	*4
"H" level maximum overall output current	ΣI_{OH1}	—	-100	mA	*4
"H" level average overall output current	ΣI_{OHAV}	—	-50	mA	*4
Power consumption	P_D	—	500	mW	MB90947A/F947A/F949A
		—	525		MB90F946A
Operating temperature	T_A	-40	+105	°C	
Storage temperature	T_{STG}	-55	+150	°C	

*1 : This parameter is based on $V_{SS} = AV_{SS} = 0$ V.

*2 : Set AV_{CC} and V_{CC} to the same voltage. Make sure that AV_{CC} does not exceed V_{CC} and that the voltage at the analog inputs does not exceed AV_{CC} when the power is switched on.

*3 : V_I and V_O should not exceed $V_{CC} + 0.3$ V. However if the maximum current to/from a input is limited by some means with external components, the I_{CLAMP} rating supercedes the V_I rating.

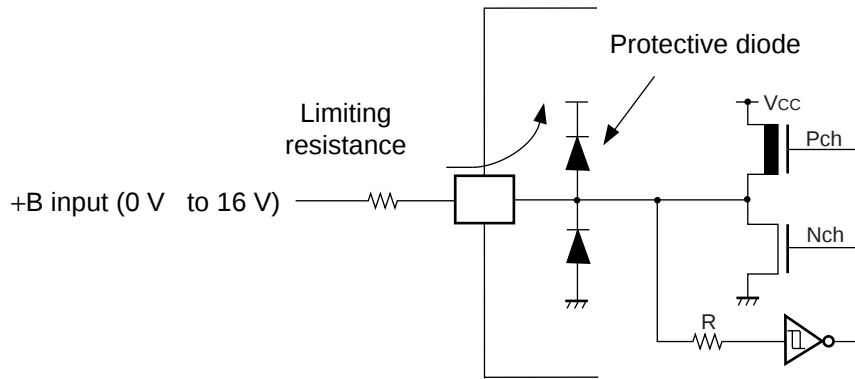
*4 : Applicable to pins : P00 to P07, P10 to P17, P20 to P27, P30 to P37, P40 to P47, P50 to P57, P60 to P67, P80, P81, P90 to P97, PA0 to PA7, PB0 to PB7

*5 : • Applicable to pins : P00 to P07, P10 to P17, P20 to P27, P30 to P37, P40 to P47, P50 to P57, P60 to P67, P80, P81, P90 to P97, PA0 to PA7, PB0 to PB7

- Use within recommended operating conditions.
- Use at DC voltage (current)
- The +B signal should always be applied a limiting resistance placed between the +B signal and the microcontroller.
- The value of the limiting resistance should be set so that when the +B signal is applied the input current to the microcontroller pin does not exceed rated values, either instantaneously or for prolonged periods.
- Note that when the microcontroller drive current is low, such as in the power saving modes, the +B input potential may pass through the protective diode and increase the potential at the V_{CC} pin, and this may affect other devices.
- Note that if a +B signal is input when the microcontroller power supply is off (not fixed at 0 V) , the power supply is provided from the pins, so that incomplete operation may result.

- Note that if the +B input is applied during power-on, the power supply is provided from the pins and the resulting supply voltage may not be sufficient to operate the power-on reset.
- Care must be taken not to leave the +B input pin open.
- Note that analog system input/output pins other than the A/D input pins (LCD drive pins, comparator input pins, etc.) cannot accept +B signal input.
- Sample recommended circuits :

- Input/output equivalent circuits



WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

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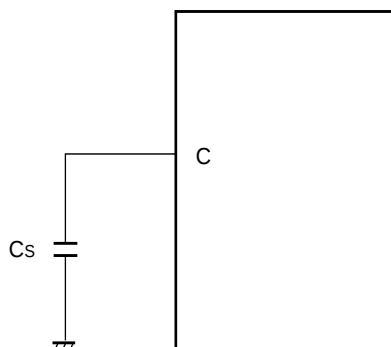
2. Recommended Conditions

($V_{SS} = AV_{SS} = 0\text{ V}$)

Parameter	Symbol	Value			Unit	Remarks
		Min	Typ	Max		
Power supply voltage	V_{CC} , AV_{CC}	3.5	5.0	5.5	V	Other than when writing to Flash memory and when using the A/D converter
		4.0	5.0	5.5	V	When writing to Flash memory
		4.5	5.0	5.5	V	When using the A/D converter
		2.0	—	5.5	V	Retain RAM data in stop mode
Smoothing capacitor	C_S	0.1	—	1.0	μF	*
Operating temperature	T_A	-40	—	+105	$^{\circ}\text{C}$	

* : Use a ceramic capacitor, or a capacitor of similar frequency characteristics. On the V_{CC} pin, use a bypass capacitor that has a larger capacity than that of C_S . Refer to the following figure for connection of smoothing capacitor C_S .

• C Pin Connection Diagram



WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.

Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their representatives beforehand.

3. DC Characteristics

($T_A = -40\text{ }^{\circ}\text{C}$ to $+105\text{ }^{\circ}\text{C}$, $V_{CC} = 5.0\text{ V} \pm 10\%$, $V_{SS} = AV_{SS} = 0\text{ V}$)

Parameter	Symbol	Pin	Condition	Value			Unit	Remarks
				Min	Typ	Max		
Input "H" voltage	V_{IHA}	—	—	$0.8 V_{CC}$	—	$V_{CC} + 0.3$	V	Port inputs except ports P21/RX1, P42/SDA, P43/SCL
	V_{IHS}	—	—	$0.7 V_{CC}$	—	$V_{CC} + 0.3$	V	Port inputs P21/RX1, P42/SDA, P43/SCL
	V_{IHR}	—	—	$0.8 V_{CC}$	—	$V_{CC} + 0.3$	V	$\overline{RST}$ input pin (CMOS Hysteresis)
	V_{IHM}	—	—	$V_{CC} - 0.3$	—	$V_{CC} + 0.3$	V	MD input pin
Input "L" voltage	V_{ILA}	—	—	$V_{SS} - 0.3$	—	$0.5 V_{CC}$	V	Port inputs except ports P21/RX1, P42/SDA, P43/SCL
	V_{ILS}	—	—	$V_{SS} - 0.3$	—	$0.3 V_{CC}$	V	Port inputs P21/RX1, P42/SDA, P43/SCL
	V_{ILR}	—	—	$V_{SS} - 0.3$	—	$0.2 V_{CC}$	V	$\overline{RST}$ input pin (CMOS Hysteresis)
	V_{ILM}	—	—	$V_{SS} - 0.3$	—	$V_{SS} + 0.3$	V	MD input pin
Output "H" voltage	V_{OH}	Normal outputs	$V_{CC} = 4.5\text{ V}$, $I_{OH1} = -4.0\text{ mA}$	$V_{CC} - 0.5$	—	—	V	
Output "H" voltage	V_{OHI}	I ² C outputs	$V_{CC} = 4.5\text{ V}$, $I_{OH1} = -3.0\text{ mA}$	$V_{CC} - 0.5$	—	—	V	
Output "L" voltage	V_{OL}	Normal outputs	$V_{CC} = 4.5\text{ V}$, $I_{OL1} = 4.0\text{ mA}$	—	—	0.4	V	
Output "L" voltage	V_{OLI}	I ² C outputs	$V_{CC} = 4.5\text{ V}$, $I_{OL1} = 3.0\text{ mA}$	—	—	0.4	V	
Input leak current	I_{IL}	—	$V_{CC} = 5.5\text{ V}$, $V_{SS} < V_I < V_{CC}$	-1	—	1	μA	

(Continued)

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(Continued)

($T_A = -40\text{ }^{\circ}\text{C}$ to $+105\text{ }^{\circ}\text{C}$, $V_{CC} = 5.0\text{ V} \pm 10\%$, $V_{SS} = AV_{SS} = 0\text{ V}$)

Parameter	Sym- bol	Pin	Condition	Value			Unit	Remarks
				Min	Typ	Max		
Pull-down resistance	R _{DOWN}	MD2	—	25	50	100	kOhm	only ROM devices
Power supply current*	I _{CC}	V _{CC}	V _{CC} = 5.0 V, Internal frequency : 24 MHz, At normal operation.	—	60	75	mA	MB90947A MB90F947A MB90F949A
				—	65	85	mA	MB90F946A
			V _{CC} = 5.0 V, Internal frequency : 20 MHz, At normal operation.	—	50	65	mA	MB90947A MB90F947A MB90F949A
				—	55	75	mA	MB90F946A
			V _{CC} = 5.0 V, Internal frequency : 20 MHz, At writing FLASH memory.	—	65	80	mA	MB90F947A MB90F949A
				—	70	90	mA	MB90F946A
			V _{CC} = 5.0 V, Internal frequency : 20 MHz, At erasing FLASH memory.	—	70	85	mA	MB90F947A MB90F949A
				—	75	95	mA	MB90F946A
			V _{CC} = 5.0 V, Internal frequency : 24 MHz, At Sleep mode.	—	25	35	mA	MB90947A MB90F947A MB90F949A
				—	28	40	mA	MB90F946A
			V _{CC} = 5.0 V, Internal frequency : 2 MHz, At Main Timebase timer mode	—	0.3	0.6	mA	MB90947A MB90F946A MB90F947A MB90F949A
			V _{CC} = 5.0 V, Internal frequency : 24 MHz, At PLL Timebase timer mode, external frequency = 4 MHz	—	5	7	mA	MB90947A MB90F946A MB90F947A MB90F949A
			V _{CC} = 5.0 V, At Stop mode, T _A = +25°C	—	5	100	μA	MB90947A MB90F946A MB90F947A MB90F949A
Input capacity	C _{IN}	Other than C, AV _{CC} , AV _{SS} , AVRH, AVRL, V _{CC} , V _{SS}	—	—	5	15	pF	

* : The power supply current is measured with an external clock.

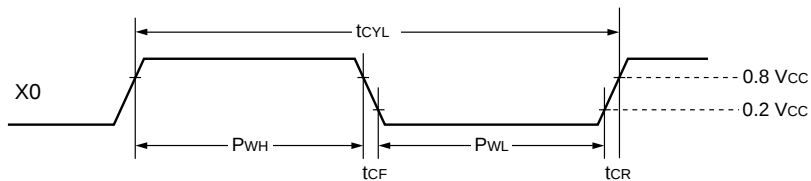
4. AC Characteristics

(1) Clock Timing

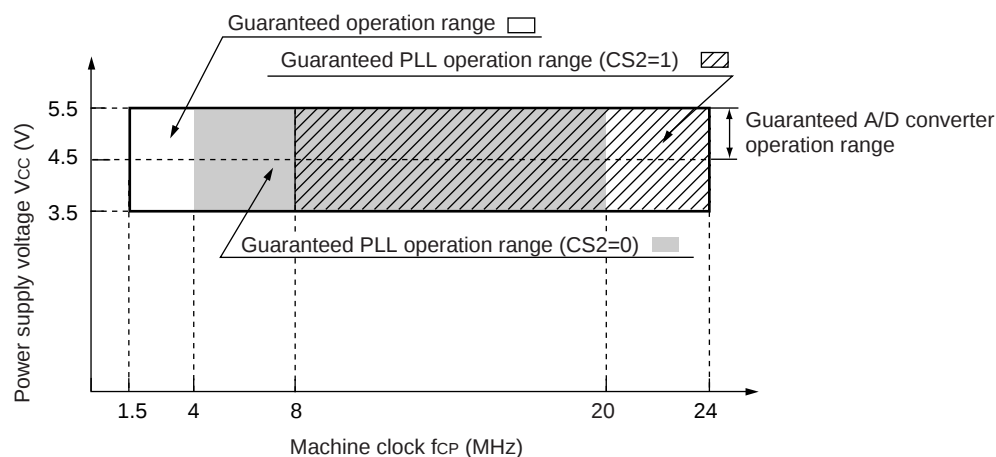
($T_A = -40\text{ }^{\circ}\text{C}$ to $+105\text{ }^{\circ}\text{C}$, $V_{CC} = 3.5\text{V}$ to 5.5V , $V_{SS} = AV_{SS} = 0\text{V}$)

Parameter	Sym- bol	Pin	Value				Unit	Remarks
			Min	Typ	Max			
					CS2 = 0	CS2 = 1		
Clock frequency	f _c	X0, X1	3	—	8	8	MHz	× 1/2 (When PLL stops) When using an oscillation circuit
			4	—	8	—	MHz	PLL × 1 When using an oscillation circuit
			4	—	8	8	MHz	PLL × 2 When using an oscillation circuit
			4	—	6.67	—	MHz	PLL × 3 When using an oscillation circuit
			4	—	5	6	MHz	PLL × 4 When using an oscillation circuit
			4	—	—	4	MHz	PLL × 6 When using an oscillation circuit
		X0	3	—	12	12	MHz	× 1/2 (When PLL stops) When using an external circuit
			4	—	12	—	MHz	PLL × 1 When using an external circuit
			4	—	10	12	MHz	PLL × 2 When using an external circuit
			4	—	6.67	—	MHz	PLL × 3 When using an external circuit
			4	—	5	6	MHz	PLL × 4 When using an external circuit
			4	—	—	4	MHz	PLL × 6 When using an external circuit
Clock cycle time	t _{CYL}	X0, X1	125	—	333		ns	When using an oscillation circuit
		X0, X1	83.33	—	333		ns	When using an external clock
Input clock pulse width	P _{WH} , P _{WL}	X0	20	—	—		ns	Duty ratio is about 30% to 70%.
Input clock rise and fall time	t _{CR} , t _{CF}	X0	—	—	5		ns	When using external clock
Machine clock frequency	f _{CP}	—	1.5	—	24		MHz	Except programming or erasing Flash memory.
		—	1.5	—	20		MHz	When programming or erasing Flash memory. Be sure that the maximum momentary frequency F _{max} does not exceed 20MHz.
Machine clock cycle time	t _{CP}	—	41.67	—	666		ns	Except programming or erasing Flash memory.
		—	50	—	666		ns	When programming or erasing Flash memory.

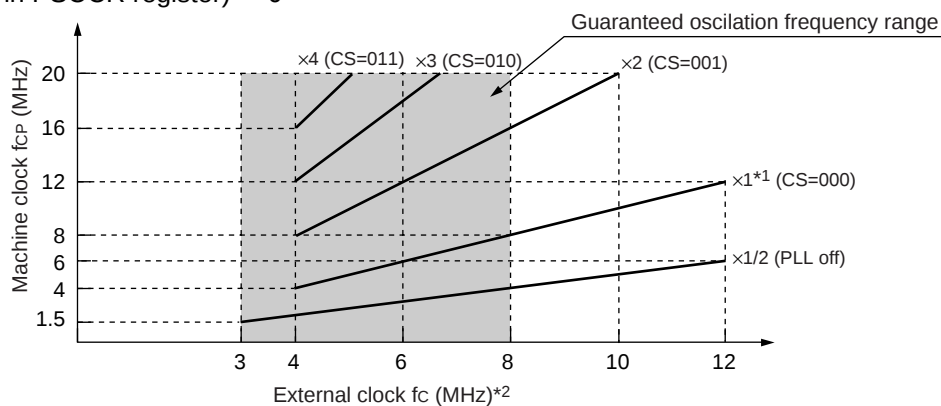
• Clock Timing



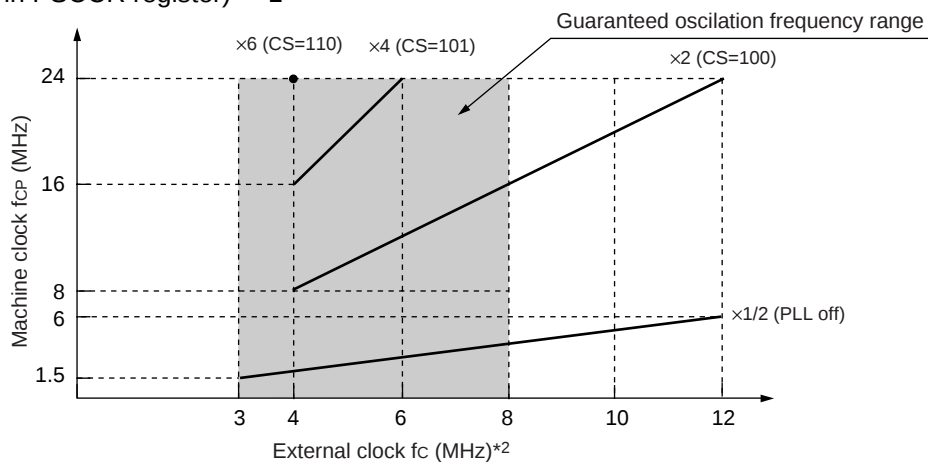
- Guaranteed PLL operation range



- CS2 (bit 0 in PSCCR register) = 0



- CS2 (bit 0 in PSCCR register) = 1



*1 : PLL $\times 1$ guaranteed operation range is from 4.0 MHz to 12 MHz.

*2 : When using a crystal oscillator or a ceramic oscillator, the maximum oscillation clock frequency is 8 MHz

External clock frequency and Machine clock frequency

(2) Reset Standby Input

($T_A = -40\text{ }^{\circ}\text{C}$ to $+105\text{ }^{\circ}\text{C}$, $V_{CC} = 3.5\text{V}$ to 5.5V , $V_{SS} = AV_{SS} = 0.0\text{V}$)

Parameter	Symbol	Pin	Value		Unit	Remarks
			Min	Max		
Reset input time	t_{RSTL}	$\overline{\text{RST}}$	$16\ t_{CP}^{*1}$	—	ns	Under normal operation
			Oscillation time of oscillator ^{*2} + 100 + $16\ t_{CP}^{*1}$	—	μs	In Stop mode
			100	—	μs	In Timebase timer mode

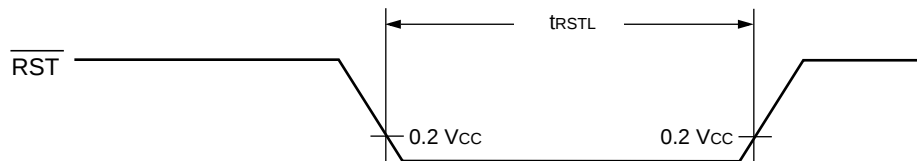
*1 : “ t_{CP} ” represents one cycle time of the machine clock.

No reset can fully initialize the Flash memory if it is performing the automatic algorithm.

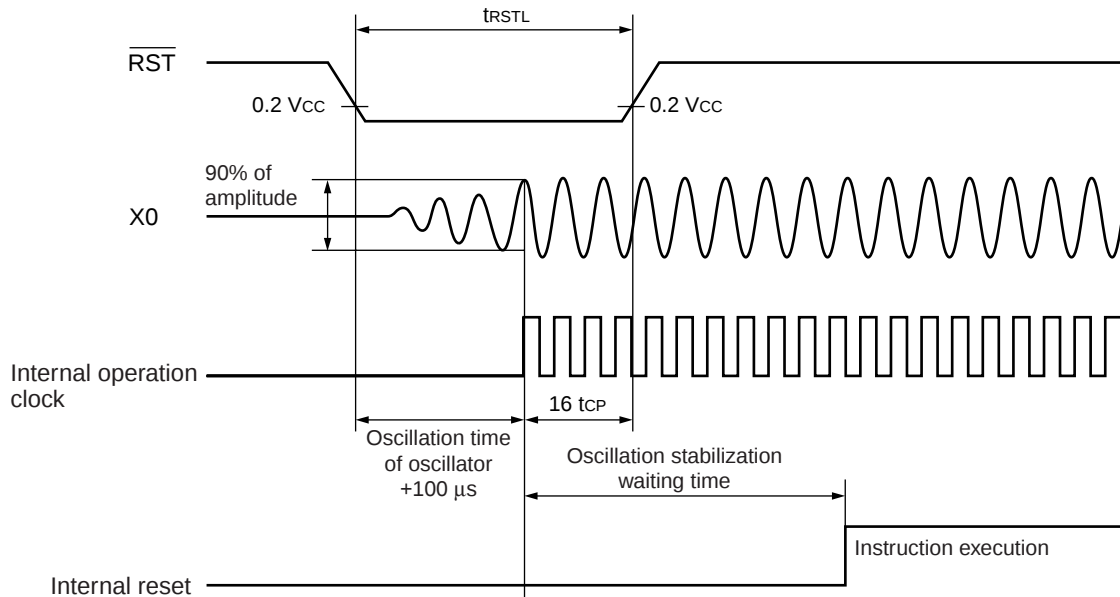
*2 : Oscillation time of oscillator is the time that the amplitude reaches 90%.

In the crystal oscillator, the oscillation time is between several ms and to tens of ms. In ceramic oscillators, the oscillation time is between hundreds of μs to several ms. With an external clock, the oscillation time is 0 ms.

Under normal operation :



In Stop mode :

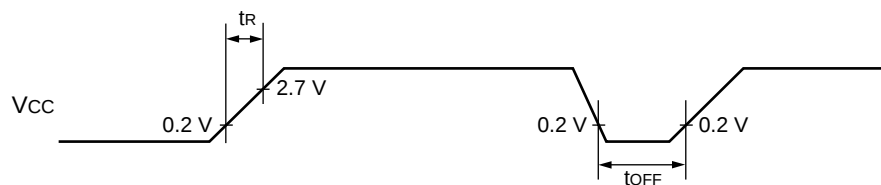


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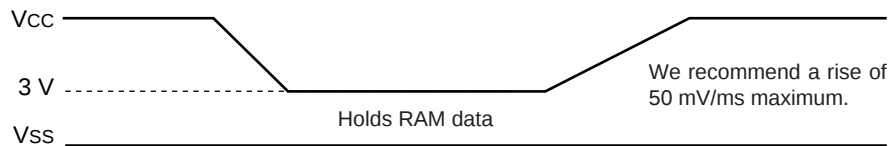
(3) Power On Reset

($T_A = -40\text{ }^{\circ}\text{C}$ to $+105\text{ }^{\circ}\text{C}$, $V_{CC} = 3.5\text{ V}$ to 5.5 V , $V_{SS} = AV_{SS} = 0.0\text{ V}$)

Parameter	Symbol	Pin	Condition	Value		Unit	Remarks
				Min	Max		
Power on rise time	t_R	V_{CC}	—	0.05	30	ms	
Power off time	t_{OFF}	V_{CC}		1	—	ms	Due to repetitive operation



If you change the power supply voltage too rapidly, a power on reset may occur. We recommend that you startup smoothly by restraining voltages when changing the power supply voltage during operation, as shown in the figure below. Perform while not using the PLL clock. However, if voltage drops are within 1 V/s, you can operate while using the PLL clock.



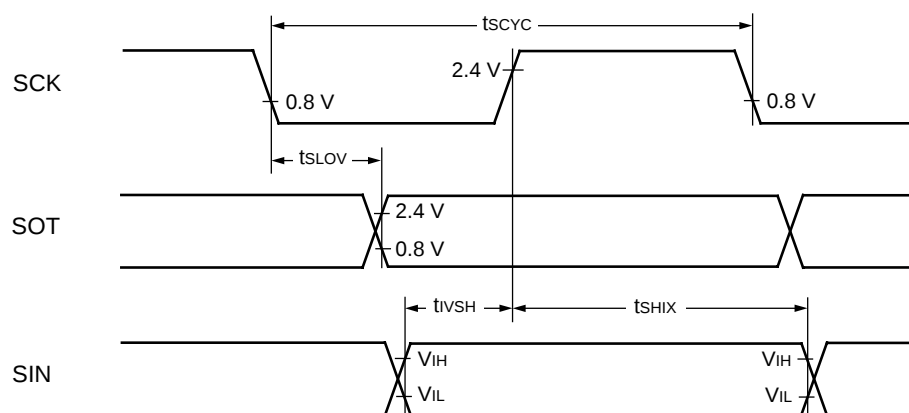
(4) UART0, SIO Timing

($T_A = -40\text{ }^{\circ}\text{C}$ to $+105\text{ }^{\circ}\text{C}$, $V_{CC} = 3.5\text{V}$ to 5.5V , $V_{SS} = AV_{SS} = 0.0\text{V}$)

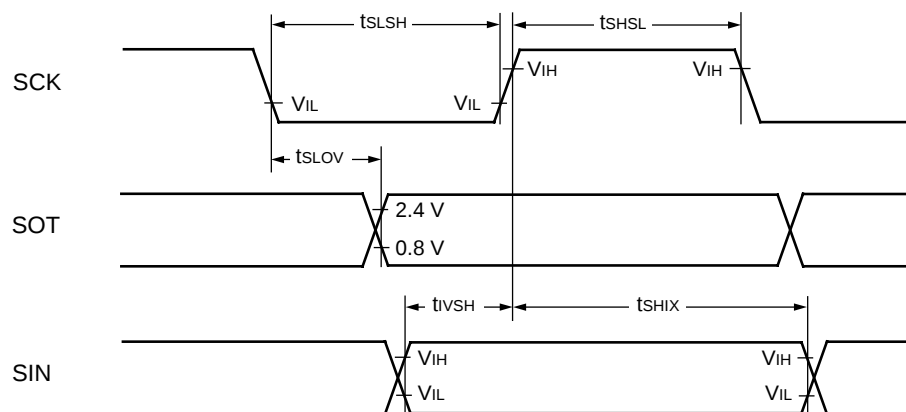
Parameter	Sym- bol	Pin	Condition	Value		Unit	Re- marks
				Min	Max		
Serial clock cycle time	t_{SCYC}	SCK0, SCK4	Internal clock operation output pins are $C_L = 80\text{ pF} + 1\text{ TTL}$.	$8\ t_{CP}$	—	ns	
SCK $\downarrow \rightarrow$ SOT delay time	t_{SLOV}	SCK0, SCK4, SOT0, SOT4		-80	+80	ns	
Valid SIN $\rightarrow$ SCK $\uparrow$	t_{IVSH}	SCK0, SCK4, SIN0, SIN4		100	—	ns	
SCK $\uparrow \rightarrow$ Valid SIN hold time	t_{SHIX}	SCK0, SCK4, SIN0, SIN4		60	—	ns	
Serial clock "H" pulse width	t_{SHSL}	SCK0, SCK4	External clock operation output pins are $C_L = 80\text{ pF} + 1\text{ TTL}$.	$4\ t_{CP}$	—	ns	
Serial clock "L" pulse width	t_{SLSH}	SCK0, SCK4		$4\ t_{CP}$	—	ns	
SCK $\downarrow \rightarrow$ SOT delay time	t_{SLOV}	SCK0, SCK4, SOT0, SOT4		—	150	ns	
Valid SIN $\rightarrow$ SCK $\uparrow$	t_{IVSH}	SCK0, SCK4, SIN0, SIN4		60	—	ns	
SCK $\uparrow \rightarrow$ Valid SIN hold time	t_{SHIX}	SCK0, SCK4, SIN0, SIN4		60	—	ns	

- Notes :
- AC characteristics in CLK synchronized mode.
 - C_L is load capacity value of pins when testing.
 - t_{CP} is the machine clock cycle time (Unit : ns) . Refer to “ (1) Clock timing” rating for t_{CP} .

- Internal Shift Clock Mode



- External Shift Clock Mode



(5) UART2/3 Timing

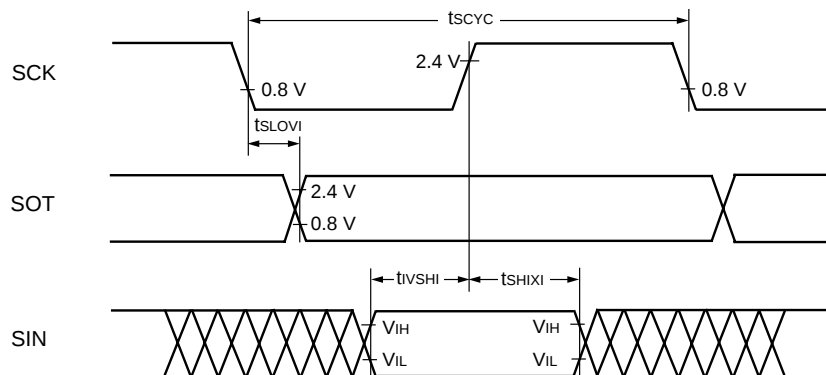
- Bit setting : ESCR : SCES = 0, ECCR : SCDE = 0

($T_A = -40\text{ }^{\circ}\text{C}$ to $+105\text{ }^{\circ}\text{C}$, $V_{CC} = 3.5\text{ V}$ to 5.5 V , $V_{SS} = AV_{SS} = 0\text{ V}$)

Parameter	Symbol	Pin	Condition	Value		Unit	Remarks
				Min	Max		
Serial clock cycle time	t_{SCYC}	SCK2,SCK3	Internal clock operation output pins are $C_L = 80\text{ pF} + 1\text{ TTL}$.	$5\text{ }t_{CP}$	—	ns	
SCK $\downarrow \rightarrow$ SOT delay time	t_{SLOVI}	SCK2,SCK3 SOT2,SOT3		-50	+50	ns	
Valid SIN $\rightarrow$ SCK $\uparrow$	t_{IVSHI}	SCK2,SCK3 SIN2,SIN3		$t_{CP} + 80$	—	ns	
SCK $\uparrow \rightarrow$ Valid SIN hold time	t_{SHIXI}	SCK2,SCK3 SIN2,SIN3		0	—	ns	
Serial clock "H" pulse width	t_{SHSL}	SCK2,SCK3	External clock operation output pins are $C_L = 80\text{ pF} + 1\text{ TTL}$.	$t_{CP} + 10$	—	ns	
Serial clock "L" pulse width	t_{SLSH}	SCK2,SCK3		$3\text{ }t_{CP} - t_R$	—	ns	
SCK $\downarrow \rightarrow$ SOT delay time	t_{SLOVE}	SCK2,SCK3 SOT2,SOT3		—	$2\text{ }t_{CP} + 60$	ns	
Valid SIN $\rightarrow$ SCK $\uparrow$	t_{IVSHE}	SCK2,SCK3 SIN2,SIN3		30	—	ns	
SCK $\uparrow \rightarrow$ Valid SIN hold time	t_{SHIXE}	SCK2,SCK3 SIN2,SIN3		$t_{CP} + 30$	—	ns	
SCK fall time	t_F	SCK2,SCK3		—	10	ns	
SCK rise time	t_R	SCK2,SCK3		—	10	ns	

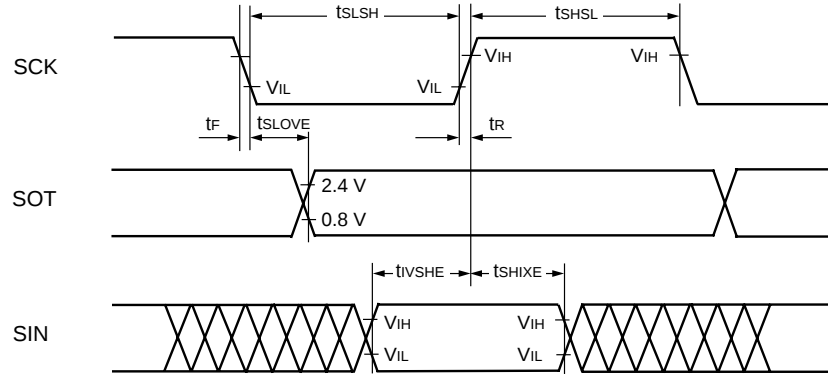
Note : t_{CP} is the machine clock cycle time (Unit : ns) . Refer to " (1) Clock timing" rating for t_{CP} .

• Internal Shift Clock Mode



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• External Shift Clock Mode



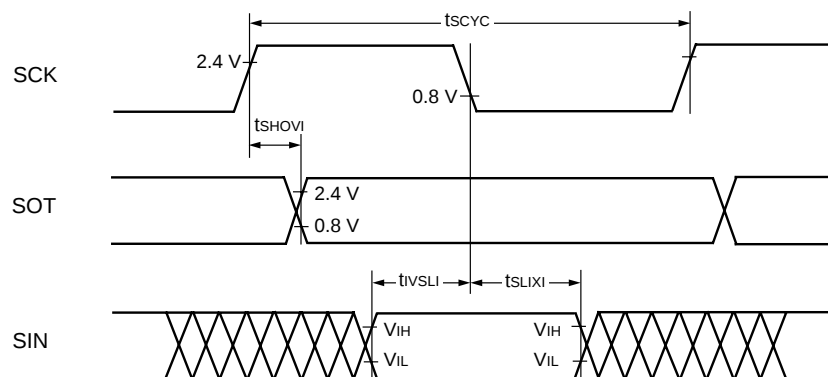
• Bit setting : ESCR : SCES = 1, ECCR : SCDE = 0

($T_A = -40\text{ }^{\circ}\text{C}$ to $+105\text{ }^{\circ}\text{C}$, $V_{CC} = 3.5\text{V}$ to 5.5V , $V_{SS} = AV_{SS} = 0\text{V}$)

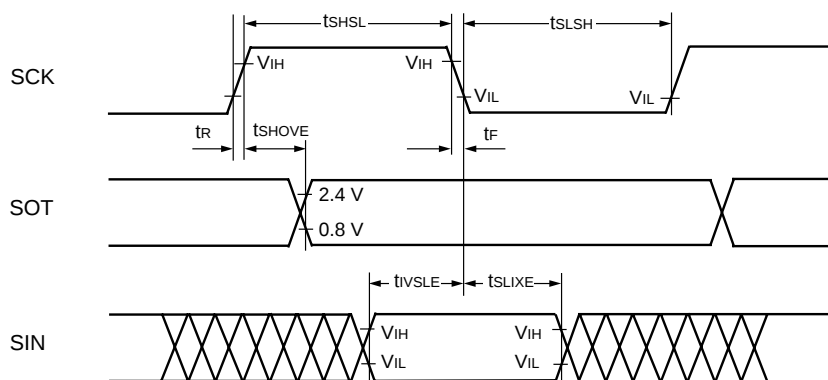
Parameter	Symbol	Pin	Condition	Value		Unit	Remarks
				Min	Max		
Serial clock cycle time	t_{SCYC}	SCK2,SCK3	Internal clock operation output pins are $C_L = 80\text{ pF} + 1\text{ TTL}$.	$5\ t_{CP}$	—	ns	
SCK $\uparrow \rightarrow$ SOT delay time	t_{SHOVI}	SCK2,SCK3 SOT2,SOT3		-50	+50	ns	
Valid SIN $\rightarrow$ SCK $\downarrow$	t_{IVSLI}	SCK2,SCK3 SIN2,SIN3		$t_{CP} + 80$	—	ns	
SCK $\downarrow \rightarrow$ Valid SIN hold time	t_{SLIXI}	SCK2,SCK3 SIN2,SIN3		0	—	ns	
Serial clock "H" pulse width	t_{SHSL}	SCK2,SCK3	External clock operation output pins are $C_L = 80\text{ pF} + 1\text{ TTL}$.	$3\ t_{CP} - t_R$	—	ns	
Serial clock "L" pulse width	t_{SLSH}	SCK2,SCK3		$t_{CP} + 10$	—	ns	
SCK $\uparrow \rightarrow$ SOT delay time	t_{SHOVE}	SCK2,SCK3 SOT2,SOT3		—	$2\ t_{CP} + 60$	ns	
Valid SIN $\rightarrow$ SCK $\downarrow$	t_{IVSLE}	SCK2,SCK3 SIN2,SIN3		30	—	ns	
SCK $\downarrow \rightarrow$ Valid SIN hold time	t_{SLIXE}	SCK2,SCK3 SIN2,SIN3		$t_{CP} + 30$	—	ns	
SCK fall time	t_F	SCK2,SCK3		—	10	ns	
SCK rise time	t_R	SCK2,SCK3		—	10	ns	

Note : t_{CP} is the machine clock cycle time (Unit : ns) . Refer to " (1) Clock timing" rating for t_{CP} .

• Internal Shift Clock Mode



• External Shift Clock Mode



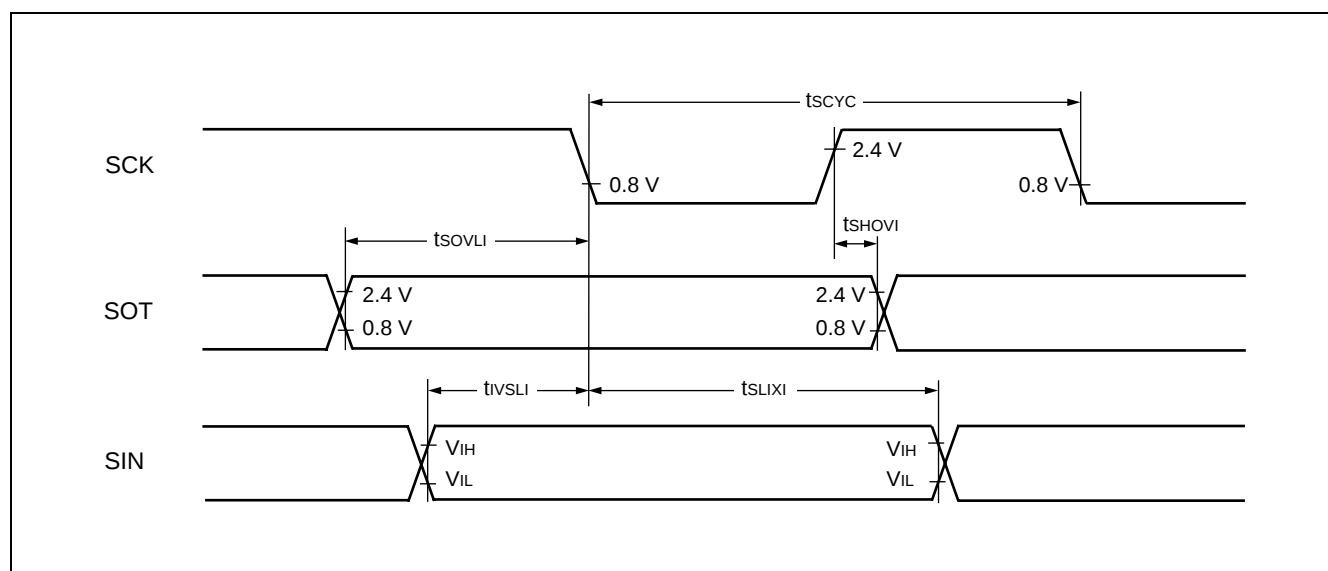
MB90945 Series

- Bit setting : ESCR : SCES = 0, ECCR : SCDE = 1

($T_A = -40\text{ }^{\circ}\text{C}$ to $+105\text{ }^{\circ}\text{C}$, $V_{CC} = 3.5\text{V}$ to 5.5V , $V_{SS} = AV_{SS} = 0\text{V}$)

Parameter	Symbol	Pin	Condition	Value		Unit	Remarks
				Min	Max		
Serial clock cycle time	t_{SCYC}	SCK2,SCK3	Internal clock operation output pins are $C_L = 80\text{ pF} + 1\text{ TTL}$.	$5\ t_{CP}$	—	ns	
SCK $\uparrow \rightarrow$ SOT delay time	t_{SHOVI}	SCK2,SCK3 SOT2,SOT3		-50	+50	ns	
Valid SIN $\rightarrow$ SCK $\downarrow$	t_{IVSLI}	SCK2,SCK3 SIN2,SIN3		$t_{CP} + 80$	—	ns	
SCK $\downarrow \rightarrow$ Valid SIN hold time	t_{SLIXI}	SCK2,SCK3 SIN2,SIN3		0	—	ns	
SOT $\rightarrow$ SCK $\downarrow$ delay time	t_{SOVLI}	SCK2,SCK3 SOT2,SOT3		$3\ t_{CP} - 70$	—	ns	

Note : t_{CP} is the machine clock cycle time (Unit : ns) . Refer to “ (1) Clock timing” rating for t_{CP} .

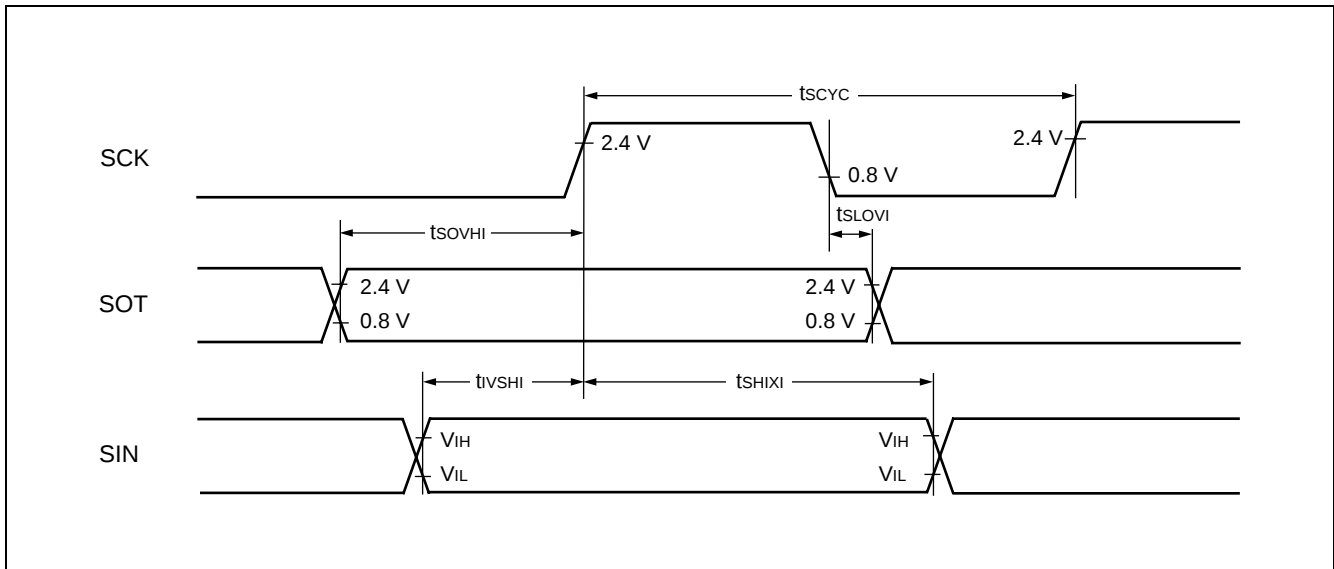


- Bit setting : ESCR : SCES = 1, ECCR : SCDE = 1

($T_A = -40\text{ }^{\circ}\text{C}$ to $+105\text{ }^{\circ}\text{C}$, $V_{CC} = 3.5\text{V}$ to 5.5V , $V_{SS} = AV_{SS} = 0\text{V}$)

Parameter	Symbol	Pin	Condition	Value		Unit	Remarks
				Min	Max		
Serial clock cycle time	t_{SCYC}	SCK2,SCK3	Internal clock operation output pins are $C_L = 80\text{ pF} + 1\text{ TTL}$.	$5\ t_{CP}$	—	ns	
SCK $\downarrow \rightarrow$ SOT delay time	t_{SLOVI}	SCK2,SCK3 SOT2,SOT3		-50	+50	ns	
Valid SIN $\rightarrow$ SCK $\uparrow$	t_{IVSHI}	SCK2,SCK3 SIN2,SIN3		$t_{CP} + 80$	—	ns	
SCK $\uparrow \rightarrow$ Valid SIN hold time	t_{SHIXI}	SCK2,SCK3 SIN2,SIN3		0	—	ns	
SOT $\rightarrow$ SCK $\uparrow$ delay time	t_{SOVHI}	SCK2,SCK3 SOT2,SOT3		$3\ t_{CP} - 70$	—	ns	

Note : t_{CP} is the machine clock cycle time (Unit : ns) . Refer to “ (1) Clock timing” rating for t_{CP} .



MB90945 Series

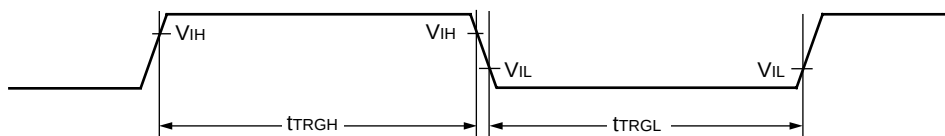
(6) Trigger Input Timing

($T_A = -40\text{ }^{\circ}\text{C}$ to $+105\text{ }^{\circ}\text{C}$, $V_{CC} = 3.5\text{V}$ to 5.5V , $V_{SS} = AV_{SS} = 0.0\text{V}$)

Parameter	Symbol	Pin	Condition	Value		Unit	Remarks
				Min	Max		
Input pulse width	t_{TRGH}	INT0 to INT7	—	200	—	ns	
	t_{TRGL}	ADTG		$t_{CP} + 200$	—	ns	

Note : t_{CP} is the machine clock cycle time (Unit : ns) . Refer to “ (1) Clock timing” rating for t_{CP} .

• Trigger Input Timing



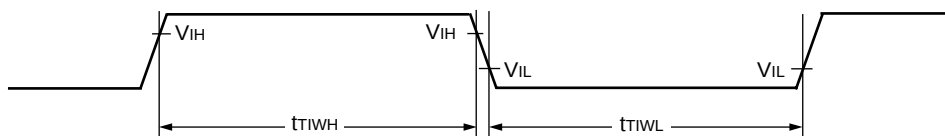
(7) Timer Related Resource Input Timing

($T_A = -40\text{ }^{\circ}\text{C}$ to $+105\text{ }^{\circ}\text{C}$, $V_{CC} = 3.5\text{V}$ to 5.5V , $V_{SS} = AV_{SS} = 0.0\text{V}$)

Parameter	Symbol	Pin	Condition	Value		Unit	Remarks
				Min	Max		
Input pulse width	t_{TIWH}	TIN0, IN0 to IN5	—	$4 t_{CP}$	—	ns	
	t_{TIWL}						

Note : t_{CP} is the machine clock cycle time (Unit : ns) . Refer to “ (1) Clock timing” rating for t_{CP} .

• Timer Input Timing



(8) I²C Timing

(T_A = -40 °C to +105 °C, V_{CC} = 3.5V to 5.5V, V_{SS} = AV_{SS} = 0.0 V)

Parameter	Symbol	Condition	Standard-mode		Fast-mode* ⁴		Unit
			Min	Max	Min	Max	
SCL clock frequency	f _{SCL}	R = 1.3 kΩ, C = 50 pF* ¹	0	100	0	400	kHz
Hold time (repeated) START condition SDA ↓ → SCL ↓	t _{HDSTA}		4.0	—	0.6	—	μs
"L" width of SCL clock	t _{LOW}		4.7	—	1.3	—	μs
"H" width of SCL clock	t _{HIGH}		4.0	—	0.6	—	μs
Set-up time for a repeated START condition SCL ↑ → SDA ↓	t _{SUSTA}		4.7	—	0.6	—	μs
Data hold time SCL ↑ → SDA ↓↑	t _{HDDAT}		0	3.45* ²	0	0.9* ³	μs
Data set-up time SDA ↓↑ → SCL ↑	t _{SUDAT}		250	—	100	—	ns
Set-up time for STOP condition SCL ↑ → SDA ↑	t _{SUSTO}		4.0	—	0.6	—	μs
Bus free time between STOP and START condition	t _{BUS}		4.7	—	1.3	—	μs

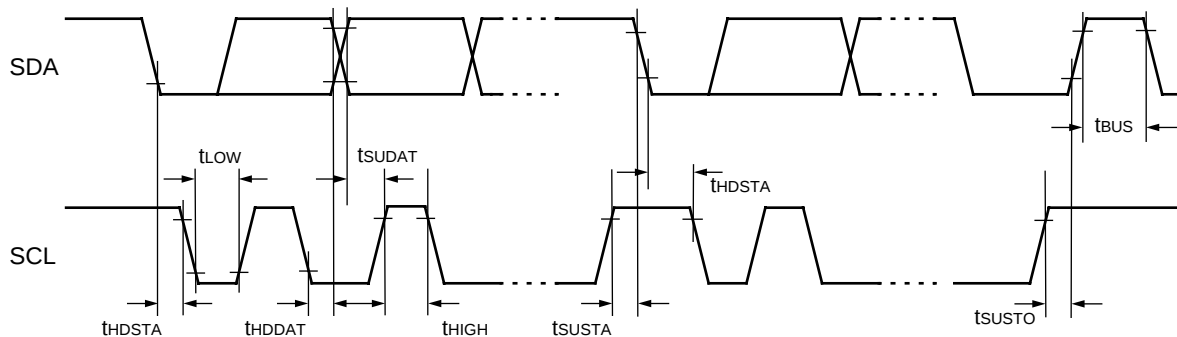
*1 : R, C : Pull-up resistor and load capacitor of the SCL and SDA lines.

*2 : The maximum t_{HDDAT} only has to be met if the device does not stretch the "L" width (t_{LOW}) of the SCL signal.

*3 : A Fast-mode I²C-bus device can be used in a Standard-mode I²C-bus system, but the requirement t_{SUDAT} ≥ 250 ns must then be met.

*4 : For use at over 100 kHz, set the machine clock to at least 6 MHz.

• I²C Timing



MB90945 Series

5. A/D Converter

($T_A = -40\text{ }^{\circ}\text{C}$ to $+105\text{ }^{\circ}\text{C}$, $3.0\text{ V} \leq \text{AVRH} - \text{AVRL}$, $V_{CC} = \text{AV}_{CC} = 5.0\text{ V} \pm 10\%$, $V_{SS} = \text{AV}_{SS} = 0\text{ V}$)

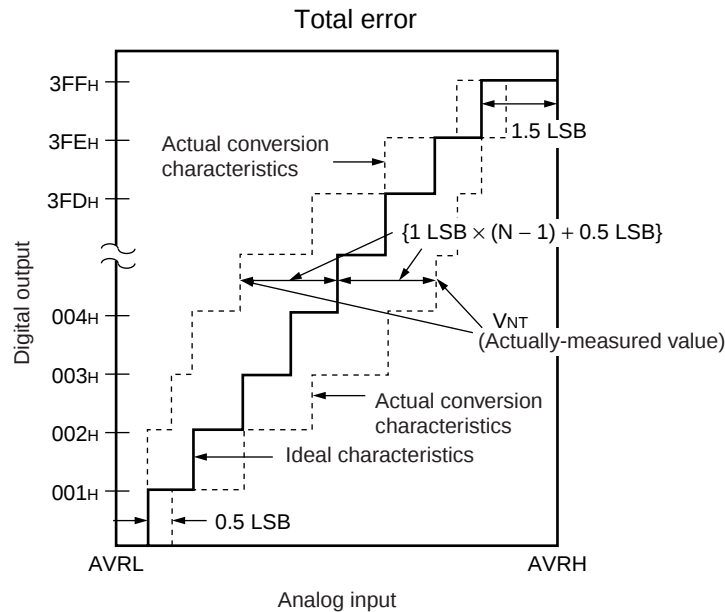
Parameter	Symbol	Pin	Value			Unit	Remarks
			Min	Typ	Max		
Resolution	—	—	—	—	10	bit	
Total error	—	—	—	—	± 3.0	LSB	
Nonlinearity error	—	—	—	—	± 2.5	LSB	
Differential nonlinearity error	—	—	—	—	± 1.9	LSB	
Zero transition voltage	V_{OT}	AN0 to AN14	$\text{AVRL} - 1.5\text{ LSB}$	$\text{AVRL} + 0.5\text{ LSB}$	$\text{AVRL} + 2.5\text{ LSB}$	V	
Full scale transition voltage	V_{FST}	AN0 to AN14	$\text{AVRH} - 3.5\text{ LSB}$	$\text{AVRH} - 1.5\text{ LSB}$	$\text{AVRH} + 0.5\text{ LSB}$	V	
Compare time	—	—	3.3	$66\text{ }t_{CP}$	16500	μs	
Sampling time	—	—	1.6	$32\text{ }t_{CP}$	∞	μs	
Analog port input current	I_{AIN}	AN0 to AN14	-0.3	—	+0.3	μA	
Analog input voltage range	V_{AIN}	AN0 to AN14	AVRL	—	AVRH	V	
Reference voltage range	—	AVRH	$\text{AVRL} + 2.7$	—	AV_{CC}	V	
		AVRL	0	—	$\text{AVRH} - 2.7$	V	
Power supply current	I_A	AV_{CC}	—	3.5	7.5	mA	
	I_{AH}	AV_{CC}	—	—	5	μA	*
Reference voltage current	I_R	AVRH	—	165	250	μA	
	I_{RH}	AVRH	—	—	5	μA	*
Offset between input channels	—	AN0 to AN14	—	—	4	LSB	

* : When not operating A/D converter, this is the current ($V_{CC} = \text{AV}_{CC} = \text{AVRH} = 5.0\text{ V}$) .

- Notes :
- t_{CP} is the machine clock cycle time (Unit : ns) . Refer to “4. AC Characteristics (1) Clock timing” rating for t_{CP}
 - The accuracy gets worse as $|\text{AVRH} - \text{AVRL}|$ becomes smaller.

6. Definition of A/D Converter Terms

- Resolution : Analog variation that is recognized by an A/D converter.
- Linear error : Deviation between a line across zero-transition line ("00 0000 0000" $\leftrightarrow$ "00 0000 0001") and full-scale transition line ("11 1111 1110" $\leftrightarrow$ "11 1111 1111") and actual conversion characteristics.
- Differential linear error : Deviation of input voltage, which is required for changing output code by 1 LSB, from an ideal value.
- Total error : Difference between an actual value and an ideal value. A total error includes zero transition error, full-scale transition error, and linear error.



$$\text{Total error of digital output "N"} = \frac{V_{NT} - \{1 \text{ LSB} \times (N - 1) + 0.5 \text{ LSB}\}}{1 \text{ LSB}} \text{ [LSB]}$$

$$1 \text{ LSB (Ideal value)} = \frac{AVRH - AVRL}{1024} \text{ [V]}$$

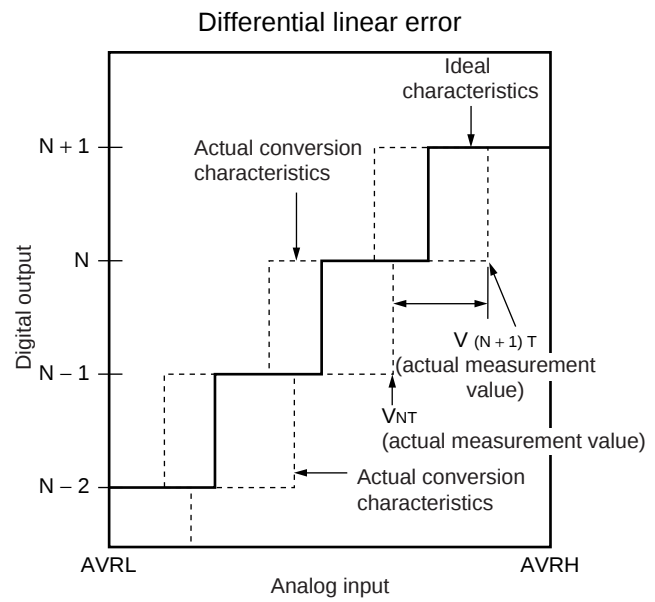
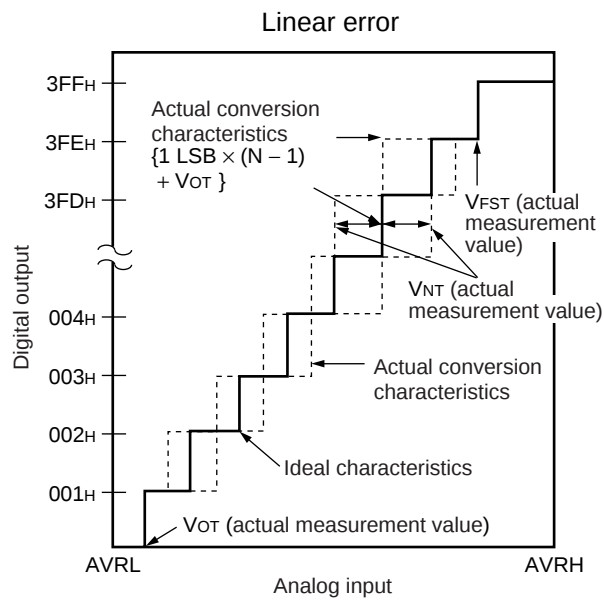
$$V_{OT} \text{ (Ideal value)} = AVRL + 0.5 \text{ LSB [V]}$$

$$V_{FST} \text{ (Ideal value)} = AVRH - 1.5 \text{ LSB [V]}$$

V_{NT} : A voltage at which digital output transitions from (N - 1) to N.

(Continued)

(Continued)



$$\text{Linear error of digital output } N = \frac{V_{NT} - \{1 \text{ LSB} \times (N - 1) + V_{OT}\}}{1 \text{ LSB}} \text{ [LSB]}$$

$$\text{Differential linear error of digital output } N = \frac{V_{(N+1)T} - V_{NT}}{1 \text{ LSB}} - 1 \text{ LSB [LSB]}$$

$$1 \text{ LSB} = \frac{V_{FST} - V_{OT}}{1022} \text{ [V]}$$

V_{OT} : Voltage at which digital output transits from "000_H" to "001_H."

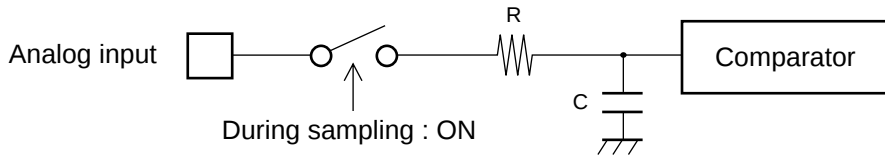
V_{FST} : Voltage at which digital output transits from "3FE_H" to "3FF_H."

7. Notes on A/D Converter Section

• About the external impedance of the analog input and its sampling time

- A/D converter with sample & hold circuit. If the external impedance is too high to keep sufficient sampling time, the analog voltage charged to the internal sample & hold capacitor is insufficient, adversely affecting A/D conversion precision.

• Analog input circuit model



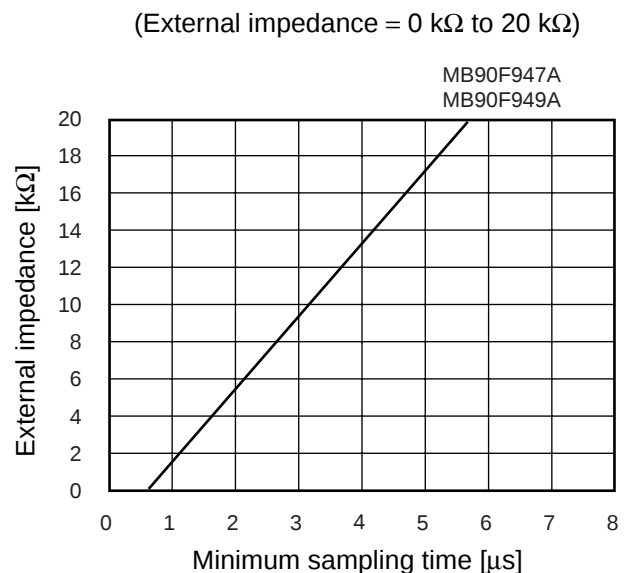
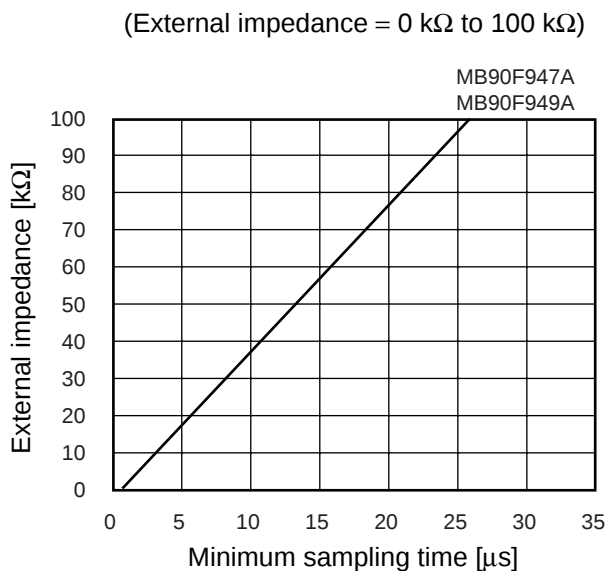
Note : The values are reference values.

MB90F946A/947A/
F947A/F949A

R	C
2.4 kΩ (Max)	36.4 pF (Max)

- To satisfy the A/D conversion precision standard, consider the relationship between the external impedance and minimum sampling time and either adjust the resistor value and operating frequency or decrease the external impedance so that the sampling time is longer than the minimum value.

• The relationship between the external impedance and minimum sampling time



- If the sampling time cannot be sufficient, connect a capacitor of about 0.1 μF to the analog input pin.

• About the error

The accuracy gets worse as $|AVRH - AVRL|$ becomes smaller.

MB90945 Series

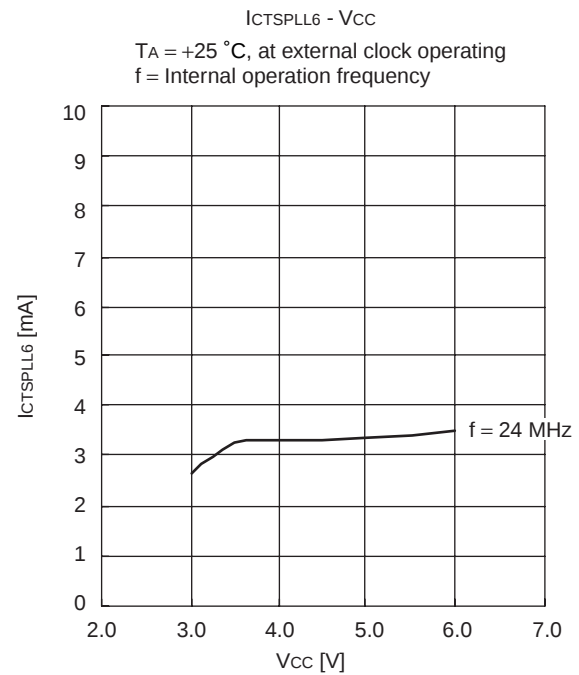
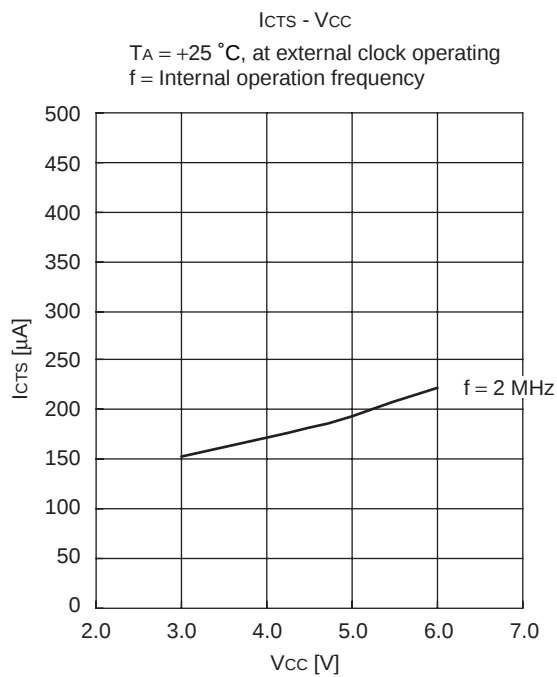
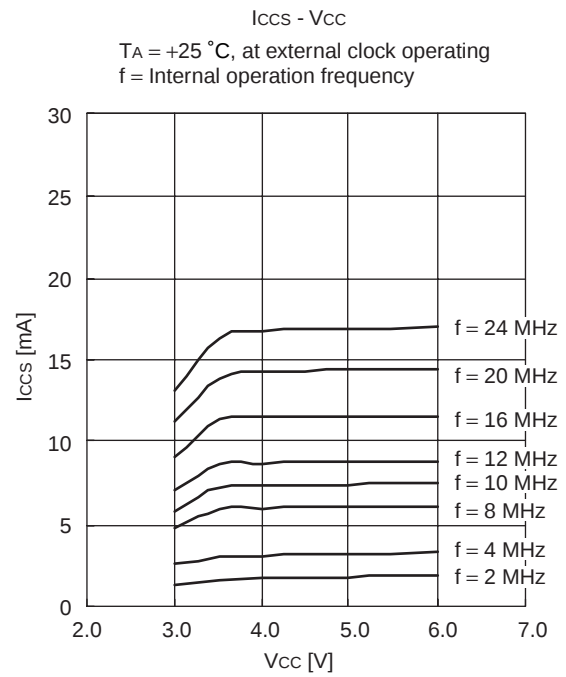
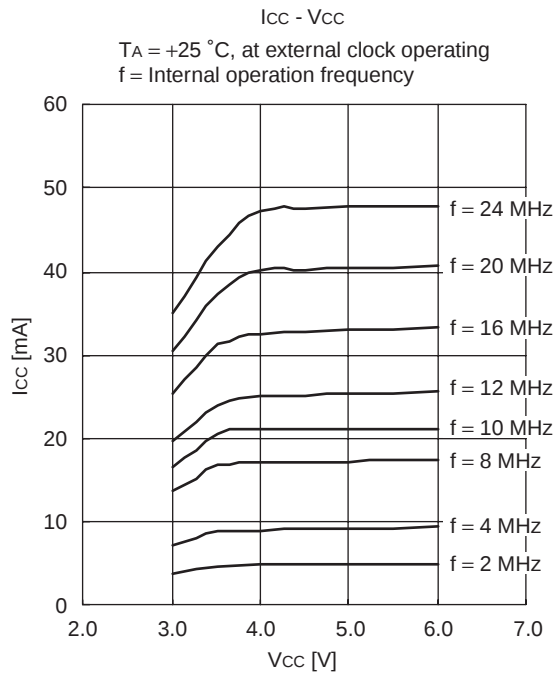
8. Flash Memory Program/Erase Characteristics

Parameter	Conditions	Value			Unit	Remarks
		Min	Typ	Max		
Sector erase time	T _A = +25 °C V _{CC} = 5.0 V	—	1	15	s	Excludes programming prior to erasure
Chip erase time		—	5	—	s	MB90F947A, Excludes programming prior to erasure
		—	7	—	s	MB90F949A, Excludes programming prior to erasure
Word (16-bit width) programming time		—	16	3,600	μs	Except for the overhead time of the system
Program/Erase cycle	—	10,000	—	—	cycle	
Flash Data Retention Time	Average T _A = +85 °C	20	—	—	Year	*

* : This value comes from the technology qualification (using Arrhenius equation to translate high temperature measurements into normalized value at +85 °C) .

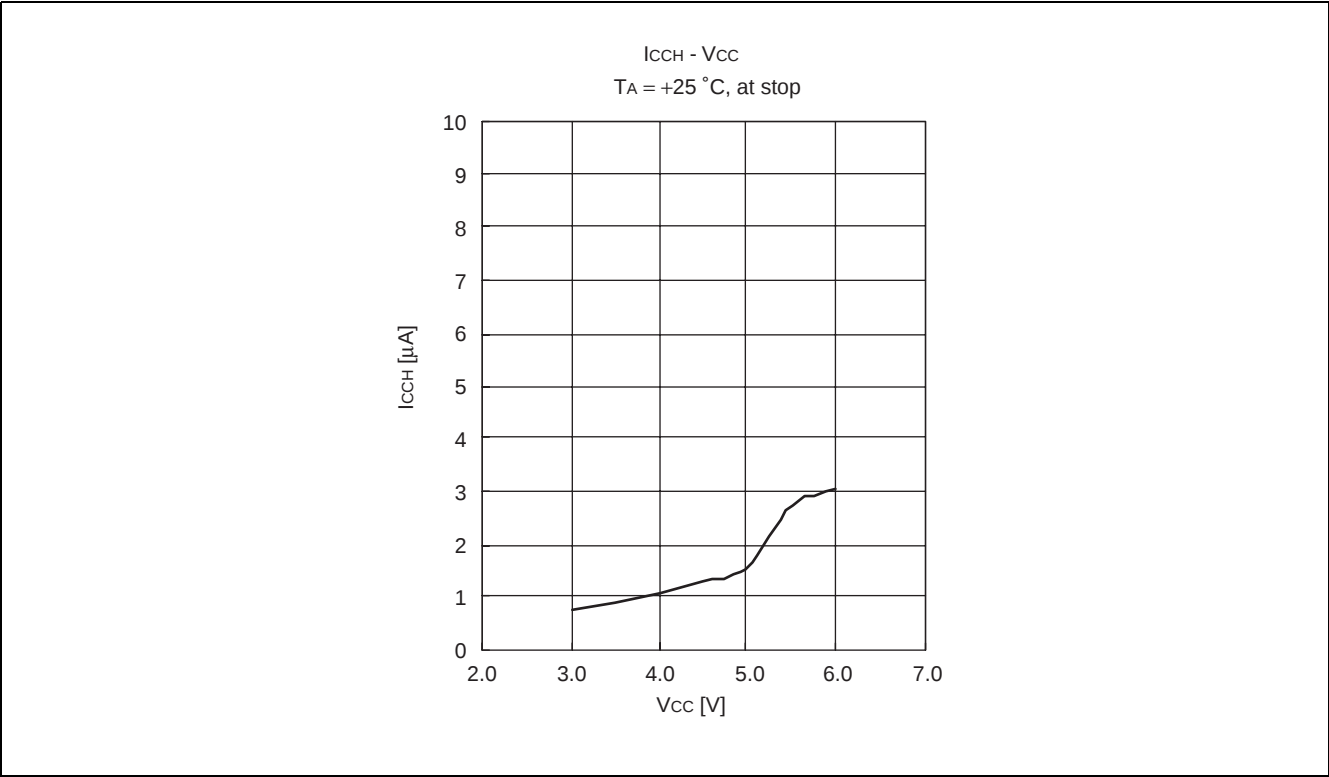
EXAMPLE CHARACTERISTICS

•MB90F947A

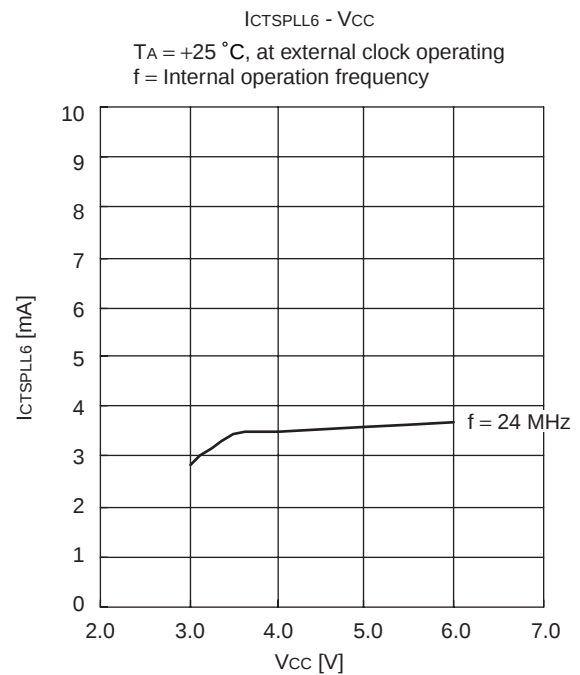
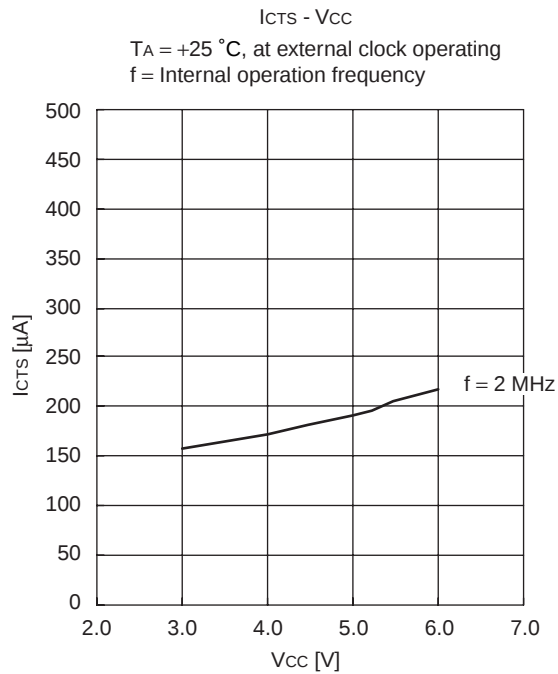
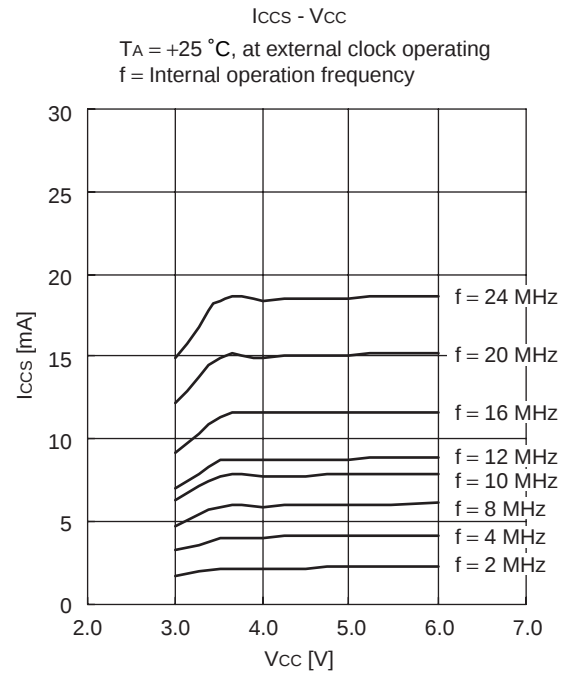
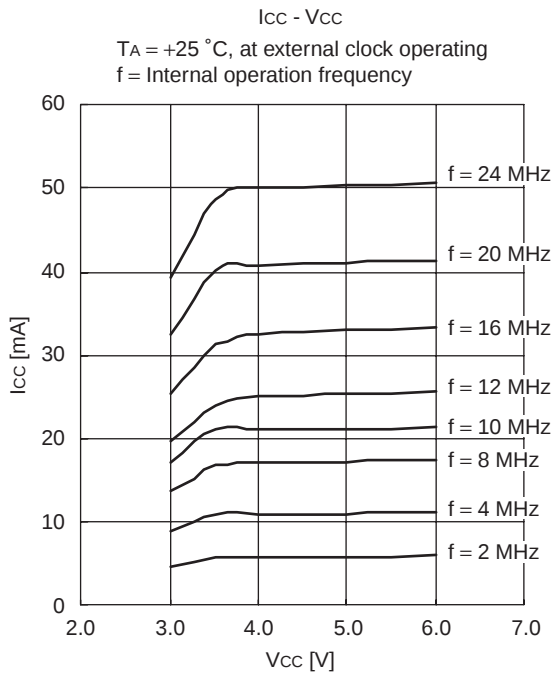


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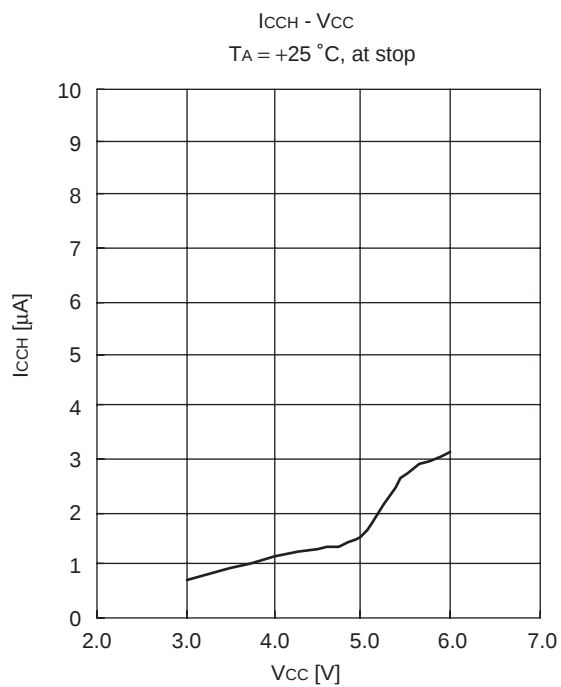


•MB90F949A



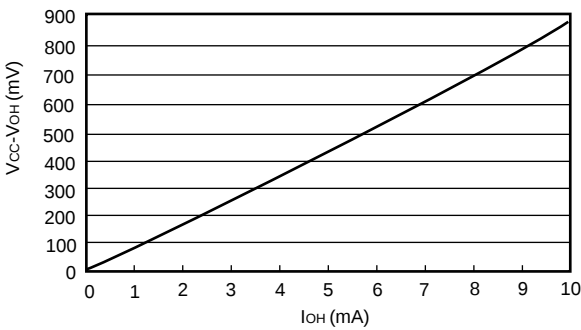
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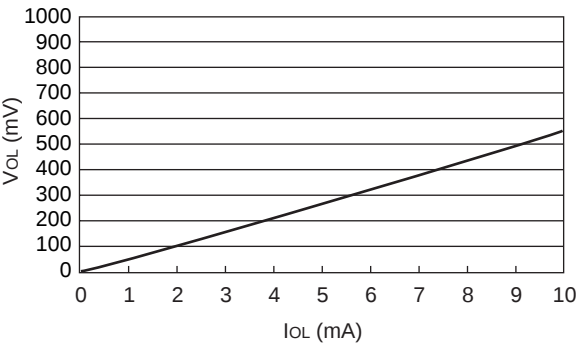


•I/O Characteristic

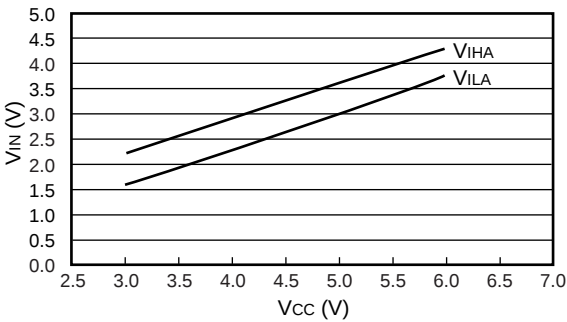
$(V_{CC}-V_{OH}) - I_{OH}$
 $T_A = +25\text{ }^{\circ}\text{C}, V_{CC} = 4.5\text{ V}$



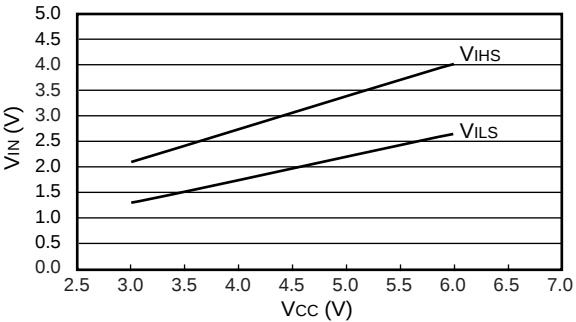
$V_{OL} - I_{OL}$
 $T_A = +25\text{ }^{\circ}\text{C}, V_{CC} = 4.5\text{ V}$



Automotive $V_{IN} - V_{CC}$
 $T_A = +25\text{ }^{\circ}\text{C}$



CMOS $V_{IN} - V_{CC}$
CAN RX pin, I²C pin
 $T_A = +25\text{ }^{\circ}\text{C}$

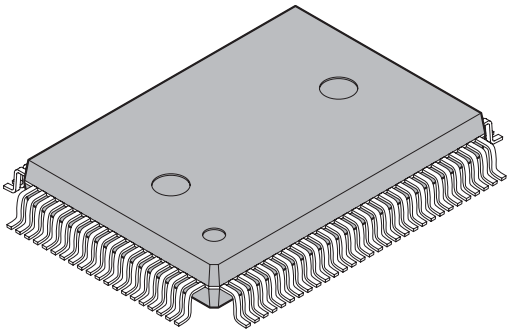


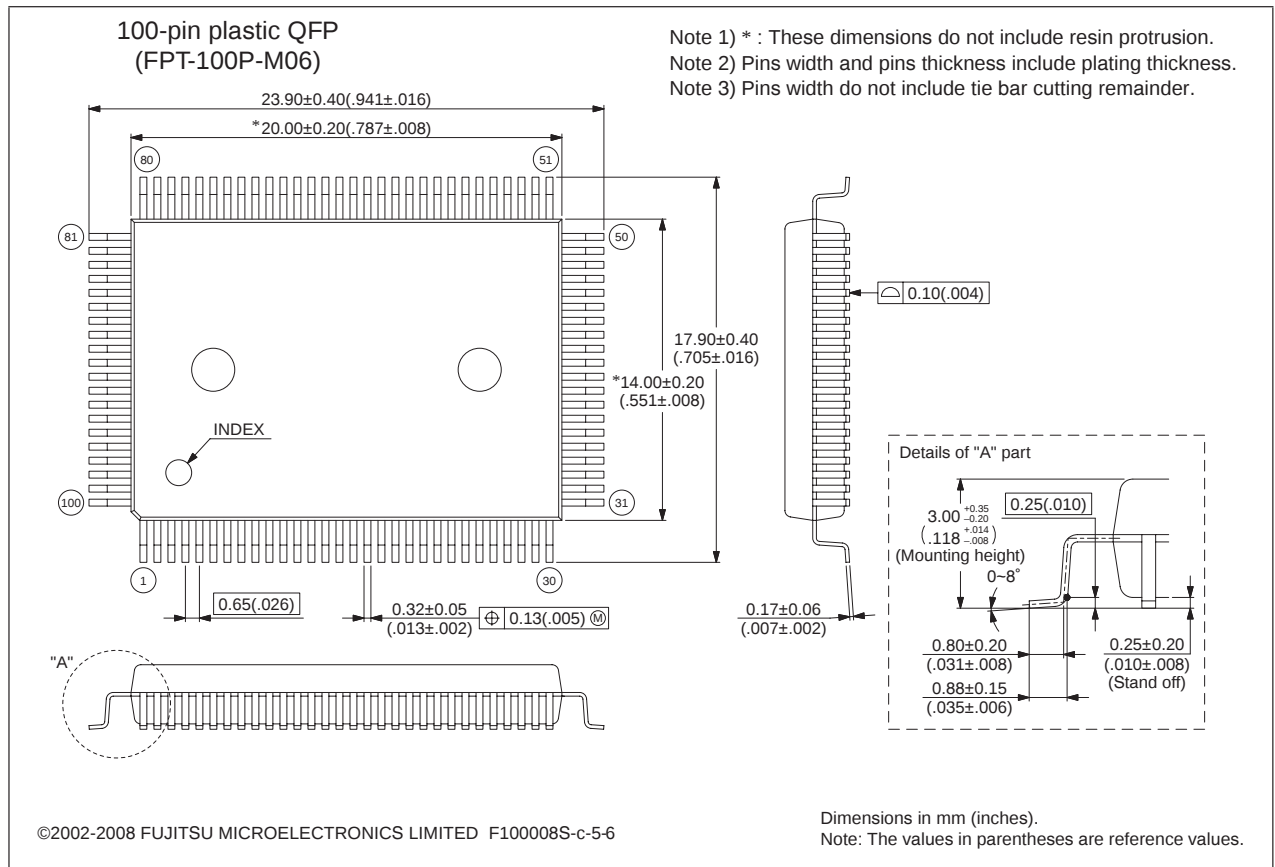
MB90945 Series

■ ORDERING INFORMATION

Part number	Package	Remarks
MB90F946APF	100-pin Plastic QFP (FPT-100P-M06)	
MB90947APF	100-pin Plastic QFP (FPT-100P-M06)	
MB90F947APF	100-pin Plastic QFP (FPT-100P-M06)	
MB90F949APF	100-pin Plastic QFP (FPT-100P-M06)	
MB90V390HBCR	299-pin Ceramic PGA (PGA-299C-A01)	For evaluation

■ PACKAGE DIMENSION

 100-pin plastic QFP (FPT-100P-M06)	Lead pitch	0.65 mm
	Package width × package length	14.00 × 20.00 mm
	Lead shape	Gullwing
	Sealing method	Plastic mold
	Mounting height	3.35 mm MAX
	Code (Reference)	P-QFP100-14×20-0.65



Please confirm the latest Package dimension by following URL.
<http://edevic.fujitsu.com/package/en-search/>

MB90945 Series

■ MAIN CHANGES IN THIS EDITION

Page	Section	Change Results
—	—	Deleted the part numbers. MB90F947, MB90F949, MB90V390HA
4	■ PRODUCT LINEUP	Changed the resource name. 16-bit I/O timer → 16-bit free-run timer
10	■ PIN DESCRIPTION	Changed the resource name. 16-bit I/O timer → 16-bit free-run time
16 to 19	■ BLOCK DIAGRAMS	Changed the resource name. I/O timer → 16-bit free-run timer
22 to 26, 28	■ I/O MAP	Add "register" for the register names. examples : Timer Control → Timer control register
26		Changed the resource name. I/O timer → 16-bit free-run timer
36	■ INTERRUPT FACTORS, INTERRUPT VECTORS, INTERRUPT CONTROL REGISTER	Changed the interrupt cause name of the interrupt vector number #32. I/O timer → 16-bit free-run timer
56	■ ELECTRICAL CHARACTERISTICS 5. A/D Converter	Changed the items of "Zero transition voltage" and "Full scale transition voltage". reading voltage → transition voltage Unit : LSB → V Value : AVRL/AVRH ± value → AVRL/AVRH ± value LSB

The vertical lines marked in the left side of the page show the changes.

MEMO

MEMO

MEMO

MB90945 Series

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